

TLV2442, TLV2442A, TLV2444, TLV2444A
Advanced LinCMOS™ RAIL-TO-RAIL OUTPUT
WIDE-INPUT-VOLTAGE OPERATIONAL AMPLIFIERS

SLOS169F – NOVEMBER 1996 – REVISED NOVEMBER 1999

- Output Swing Includes Both Supply Rails
- Extended Common-Mode Input Voltage Range . . . 0 V to 4.25 V (Min) at 5-V Single Supply
- No Phase Inversion
- Low Noise . . . 16 nV/ $\sqrt{\text{Hz}}$ Typ at $f = 1 \text{ kHz}$
- Low Input Offset Voltage 950 μV Max at $T_A = 25^\circ\text{C}$ (TLV244xA)
- Low Input Bias Current . . . 1 pA Typ
- 600- Ω Output Drive
- High-Gain Bandwidth . . . 1.8 MHz Typ
- Low Supply Current . . . 750 μA Per Channel Typ
- Macromodel Included
- Available in Q-Temp Automotive HighRel Automotive Applications Configuration Control / Print Support Qualification to Automotive Standards

description

The TLV244x and TLV244xA are low-voltage operational amplifiers from Texas Instruments. The common-mode input voltage range of these devices has been extended over typical standard CMOS amplifiers, making them suitable for a wide range of applications. In addition, these devices do not phase invert when the common-mode input is driven to the supply rails. This satisfies most design requirements without paying a premium for rail-to-rail input performance. They also exhibit rail-to-rail output performance for increased dynamic range in single- or split-supply applications. This family is fully characterized at 3-V and 5-V supplies and is optimized for low-voltage operation. Both devices offer comparable ac performance while having lower noise, input offset voltage, and power dissipation than existing CMOS operational amplifiers. The TLV244x has increased output drive over previous rail-to-rail operational amplifiers and can drive 600- Ω loads for telecommunications applications.

The other members in the TLV244x family are the low-power, TLV243x, and micro-power, TLV2422, versions.

The TLV244x, exhibiting high input impedance and low noise, is excellent for small-signal conditioning for high-impedance sources, such as piezoelectric transducers. Because of the micropower dissipation levels and low-voltage operation, these devices work well in hand-held monitoring and remote-sensing applications. In addition, the rail-to-rail output feature with single- or split-supplies makes this family a great choice when interfacing with analog-to-digital converters (ADCs). For precision applications, the TLV244xA is available with a maximum input offset voltage of 950 μV .

If the design requires single operational amplifiers, see the TI TLV2211/21/31. This is a family of rail-to-rail output operational amplifiers in the SOT-23 package. Their small size and low power consumption make them ideal for high density, battery-powered equipment.

HIGH-LEVEL OUTPUT VOLTAGE
vs
HIGH-LEVEL OUTPUT CURRENT

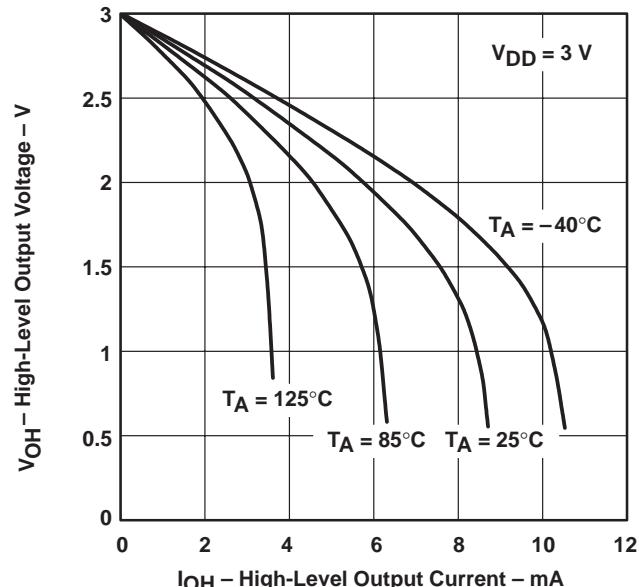


Figure 1



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TLV2442 AVAILABLE OPTIONS

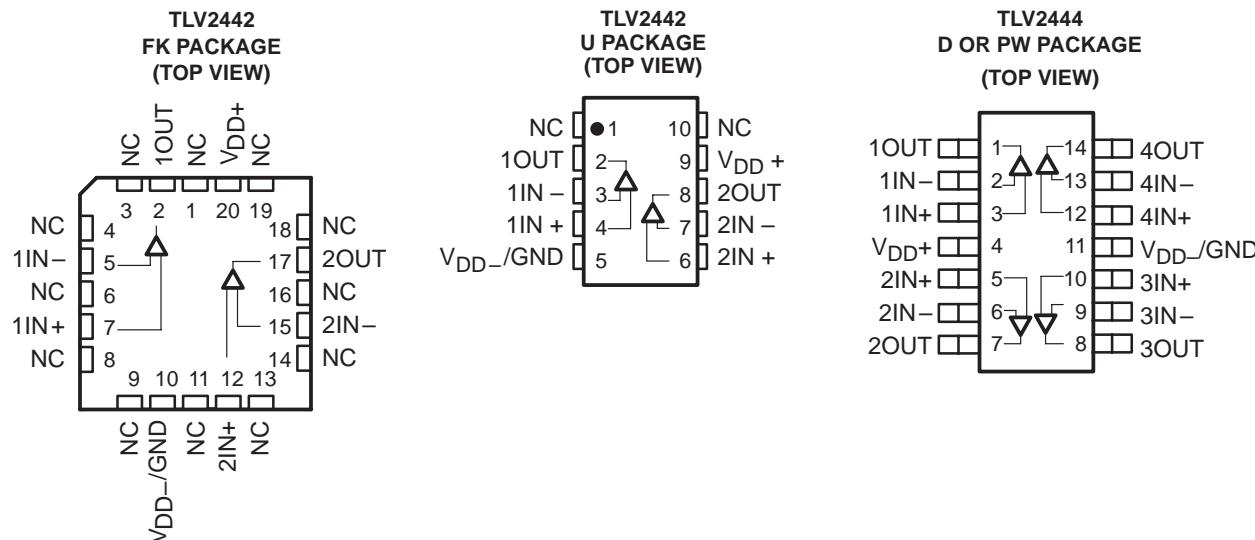
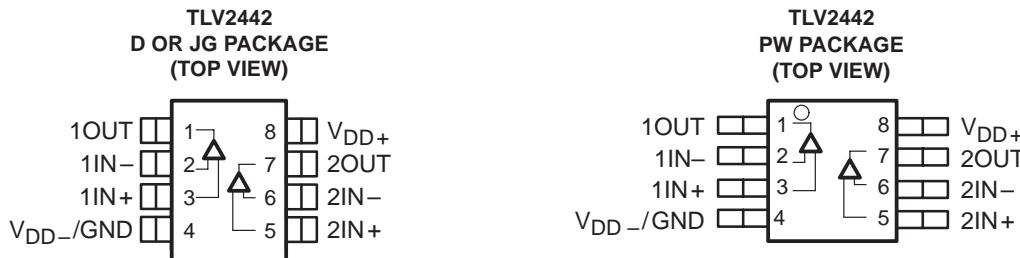
TA	$V_{IO\max}$ AT 25°C	PACKAGED DEVICES				
		SMALL OUTLINE (D)	CHIP CARRIER (FK)	CERAMIC DIP (JG)	TSSOP (PW)	CERAMIC FLAT PACK (U)
0°C to 70°C	2.5 mV	TLV2442CD	—	—	TLV2442CPW	—
-40°C to 85°C	950 µV 2.5 mV	TLV2442AID TLV2442ID	—	—	TLV2442AIPW	—
-40°C to 125°C	950 µV 2.5 mV	TLV2442AQD TLV2442QD	—	—	—	—
-55°C to 125°C	950 µV 2.5 mV	—	TLV2442AMFK TLV2442MFK	TLV2442AMJG TLV2442MJG	—	TLV2442AMU TLV2442MU

The D and PW packages are available taped and reeled. Add R suffix to device type (e.g., TLV2442CDR).

TLV2444 AVAILABLE OPTIONS

TA	$V_{IO\max}$ AT 25°C	PACKAGED DEVICES	
		SMALL OUTLINE (D)	TSSOP (PW)
0°C to 70°C	2.5 mV	TLV2444CD	TLV2444CPW
-40°C to 125°C	950 µV 2.5 mV	TLV2444AID TLV2444ID	TLV2444AIPW TLV2444IPW

The D and PW packages are available taped and reeled. Add R suffix to device type (e.g., TLV2444CDR).

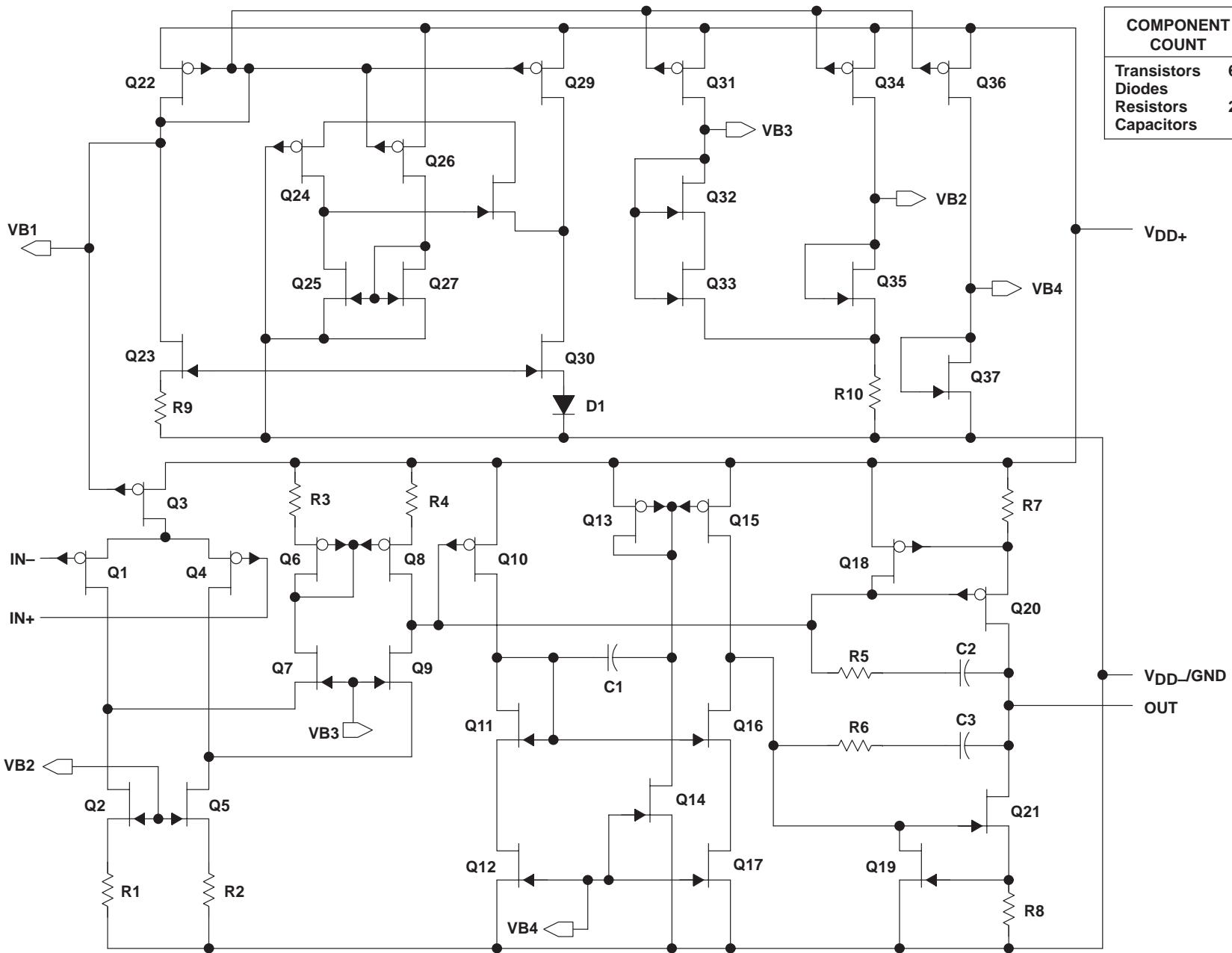


NC – No internal connection

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equivalent schematic (each amplifier)



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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V_{DD} (see Note 1)	12 V
Differential input voltage, V_{ID} (see Note 2)	$\pm V_{DD}$
Input voltage, V_I (any input, see Note 1)	-0.3 V to V_{DD}
Input current, I_I (any input)	± 5 mA
Output current, I_O	± 50 mA
Total current into V_{DD+}	± 50 mA
Total current out of V_{DD-}	± 50 mA
Duration of short-circuit current at (or below) 25°C (see Note 3)	unlimited
Continuous total dissipation	See Dissipation Rating Table
Operating free-air temperature range, T_A : C suffix	0°C to 70°C
I suffix (dual)	-40°C to 85°C
I suffix (quad)	-40°C to 125°C
Q suffix	-40°C to 125°C
M suffix	-55°C to 125°C
Storage temperature range, T_{stg}	-65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	260°C

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. All voltage values, except differential voltages, are with respect to the midpoint between V_{DD+} and V_{DD-} .
 2. Differential voltages are at IN+ with respect to IN-. Excessive current will flow if input is brought below $V_{DD-} - 0.3$ V.
 3. The output may be shorted to either supply. Temperature and/or supply voltages must be limited to ensure that the maximum dissipation rating is not exceeded.

DISSIPATION RATING TABLE

PACKAGE	$T_A \leq 25^\circ\text{C}$ POWER RATING	DERATING FACTOR ABOVE $T_A = 25^\circ\text{C}$	$T_A = 70^\circ\text{C}$ POWER RATING	$T_A = 85^\circ\text{C}$ POWER RATING	$T_A = 125^\circ\text{C}$ POWER RATING
D (8)	725 mW	5.8 mW/°C	464 mW	377 mW	145 mW
D (14)	1022 mW	7.6 mW/°C	900 mW	777 mW	450 mW
FK	1375 mW	11.0 mW/°C	880 mW	715 mW	275 mW
JG	1050 mW	8.4 mW/°C	672 mW	546 mW	210 mW
PW (8)	525 mW	4.2 mW/°C	336 mW	273 mW	105 mW
PW (14)	720 mW	5.6 mW/°C	634 mW	547 mW	317 mW
U	675 mW	5.4 mW/°C	432 mW	350 mW	135 mW

recommended operating conditions

	C SUFFIX		I SUFFIX		Q SUFFIX		M SUFFIX		UNIT
	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
Supply voltage, V_{DD}	2.7	10	2.7	10	2.7	10	2.7	10	V
Input voltage range, V_I	$V_{DD-} - V_{DD+} - 1$	$V_{DD-} - V_{DD+} - 1$	$V_{DD-} - V_{DD+} - 1$	$V_{DD-} - V_{DD+} - 1.3$	V				
Common-mode input voltage, V_{IC}	$V_{DD-} - V_{DD+} - 1$	$V_{DD-} - V_{DD+} - 1$	$V_{DD-} - V_{DD+} - 1$	$V_{DD-} + 2 - V_{DD+} - 1.3$	V				
Operating free-air temperature, T_A	0	70	-40	125	-40	125	-55	125	°C



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electrical characteristics at specified free-air temperature, $V_{DD} = 3\text{ V}$ (unless otherwise noted)

PARAMETER	TEST CONDITIONS	T_A^\dagger	TLV2442			UNIT	
			MIN	TYP	MAX		
V_{IO} Input offset voltage	$V_{IC} = 1.5\text{ V}$, $V_O = 1.5\text{ V}$, $R_S = 50\Omega$	TLV244xC	25°C	300	2000	μV	
		TLV244xI	Full range		2500		
		TLV244xAI	25°C	300	950		
			Full range		1500		
		TLV2442AQ	25°C	300	950		
			Full range		1600		
		TLV2442AM	25°C to 85°C		2	$\mu\text{V}/^\circ\text{C}$	
			25°C		0.002	$\mu\text{V}/\text{mo}$	
			25°C		0.5	pA	
I_{IO} Input offset current		Full range			150		
		TLV2442Q/AQ	25°C		1		
			–40°C to 85°C		150		
			125°C		350		
		TLV2442M/AM	Full range		260		
V_{ICR} Common-mode input voltage range	$ V_{IO} \leq 5\text{ mV}$, $R_S = 50\Omega$	25°C	0	–0.25	V		
			to	to			
		Full range	2.25	2.5			
			0	to			
		25°C to –55°C	2	0			
V_{OH} High-level output voltage	$I_O = -100\text{ }\mu\text{A}$	25°C	–0.25	to	V		
		25°C	to	2.5			
			2.25	2.5			
V_{OL} Low-level output voltage	$I_O = -3\text{ mA}$	Full range	0	to	V		
		25°C	2	0			
			125°C	to			
A_{VD} Large-signal differential voltage amplification	$V_{IC} = 1.5\text{ V}$, $I_O = 100\text{ }\mu\text{A}$	25°C	0.02		V		
		25°C	0.63				
			Full range	1			
		$V_{IC} = 1.5\text{ V}$, $I_O = 3\text{ mA}$	25°C	0.7	1	V/mV	
			Full range	0.4			
r_{id} Differential input resistance	$V_O = 1\text{ V to }2\text{ V}$	$R_L = 600\Omega$	25°C	750			
			25°C	1000	$\text{G}\Omega$		
		$R_L = 1\text{ M}\Omega$	25°C	1000	$\text{G}\Omega$		
r_j Common-mode input resistance		$f = 10\text{ kHz}$		25°C	8	pF	
		$f = 1\text{ MHz}$, $A_V = 10$		25°C	130	Ω	

† Full range for the C suffix is 0°C to 70°C. Full range for the dual I suffix is –40°C to 85°C. Full range for the quad I suffix is –40°C to 125°C. Full range for the Q suffix is –40°C to 125°C. Full range for the M suffix is –55°C to 125°C.

NOTE 4: Typical values are based on the input offset voltage shift observed through 168 hours of operating life test at $T_A = 150^\circ\text{C}$ extrapolated to $T_A = 25^\circ\text{C}$ using the Arrhenius equation and assuming an activation energy of 0.96 eV.

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**electrical characteristics at specified free-air temperature, $V_{DD} = 3$ V (unless otherwise noted)
(continued)**

PARAMETER	TEST CONDITIONS	T_A^\dagger	TLV2442			UNIT
			MIN	TYP	MAX	
CMRR Common-mode rejection ratio	$V_{IC} = 0$ to 2.25 V, $V_O = 1.5$ V, $R_S = 50 \Omega$	25°C	65	75		dB
		Full range	55			
		Full range	50			
k_{SVR} Supply-voltage rejection ratio ($\Delta V_{DD} \pm \Delta V_O$)	$V_{DD} = 2.7$ V to 8 V, No load	25°C	80	95		dB
		Full range	80			
I_{DD} Supply current (per channel)	$V_O = 1.5$ V, No load	25°C	725	1100		μA
		Full range		1100		

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operating characteristics at specified free-air temperature, $V_{DD} = 3$ V

PARAMETER	TEST CONDITIONS	T_A^\dagger	TLV244x			UNIT
			MIN	TYP	MAX	
SR Slew rate at unity gain	$V_O = 1$ V to 2 V, $R_L = 600 \Omega$, $C_L = 100 \text{ pF}$	25°C	0.65	1.3		V/ μs
		Full range	0.65			
		Full range	0.4			
V_n Equivalent input noise voltage	$f = 10$ Hz	25°C	170			$\text{nV}/\sqrt{\text{Hz}}$
		25°C	18			
$V_{N(PP)}$ Peak-to-peak equivalent input noise voltage	$f = 0.1$ Hz to 1 Hz	25°C	2.6			μV
		25°C	5.1			
I_n Equivalent input noise current		25°C	0.6			$\text{fA}/\sqrt{\text{Hz}}$
THD + N Total harmonic distortion plus noise	$V_O = 0.5$ V to 2.5 V, $R_L = 600 \Omega$, $f = 1$ kHz	$A_V = 1$ $A_V = 10$ $A_V = 100$	25°C	0.08%		
				0.3%		
				2%		
Gain-bandwidth product	$f = 10$ kHz, $R_L = 600 \Omega$, $C_L = 100 \text{ pF}$		25°C	1.75		MHz
BOM Maximum output-swing bandwidth	$V_O(\text{PP}) = 1$ V, $A_V = 1$,	$R_L = 600 \Omega$, $C_L = 100 \text{ pF}$	25°C	0.9		MHz
t_s Settling time	$A_V = -1$, Step = –2.3 V to 2.3 V, $R_L = 600 \Omega$, $C_L = 100 \text{ pF}$	To 0.1%	25°C	1.5		μs
		To 0.01%		3.2		
ϕ_m Phase margin at unity gain	$R_L = 600 \Omega$, $C_L = 100 \text{ pF}$	25°C	65°			dB
		25°C	9			

† Full range for the C suffix is 0°C to 70°C. Full range for the dual I suffix is –40°C to 85°C. Full range for the quad I suffix is –40°C to 125°C. Full range for the Q suffix is –40°C to 125°C. Full range for the M suffix is –55°C to 125°C.

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electrical characteristics at specified free-air temperature, $V_{DD} = 5$ V (unless otherwise noted)

PARAMETER	TEST CONDITIONS	$T_A \dagger$	TLV244X			UNIT
			MIN	TYP	MAX	
V_{IO} Input offset voltage	$V_{DD} \pm 2.5$ V, $V_{IC} = 0$, $V_O = 0$, $R_S = 50 \Omega$	TLV244xC TLV244xI	25°C	300	2000	μV
		TLV244xA	25°C	300	950	
		TLV2442AQ TLV2442AM	25°C	300	1500	
		TLV2442AQ TLV2442M/AM	25°C	300	950	
		TLV2442Q/AQ TLV2442M/AM	Full range	2	1600	$\mu\text{V}/^\circ\text{C}$
		TLV2442Q/AQ TLV2442M/AM	25°C	0.002	0.5	$\mu\text{V}/\text{mo}$
		TLV2442Q/AQ TLV2442M/AM	Full range	150	1	pA
		TLV2442Q/AQ TLV2442M/AM	25°C	150	350	pA
I_{IO} Input offset current	$ V_{IO} \leq 5$ mV, $R_S = 50 \Omega$	TLV2442Q/AQ TLV2442M/AM	125°C	260	1	pA
		TLV2442Q/AQ TLV2442M/AM	25°C	4.5	0.5	
		TLV2442Q/AQ TLV2442M/AM	Full range	4	0.25	
		TLV2442Q/AQ TLV2442M/AM	Full range	4	0	
V_{OH} High-level output voltage	$I_{OH} = -100 \mu\text{A}$	TLV2442Q/AQ TLV2442M/AM	25°C	4.97	4	V
		TLV2442Q/AQ TLV2442M/AM	25°C	4.35	4	
		TLV2442Q/AQ TLV2442M/AM	Full range	4	4	
V_{OL} Low-level output voltage	$V_{IC} = 2.5$ V, $I_{OL} = 100 \mu\text{A}$	TLV2442Q/AQ TLV2442M/AM	25°C	0.01	0.01	V
		TLV2442Q/AQ TLV2442M/AM	25°C	0.8	0.01	
		TLV2442Q/AQ TLV2442M/AM	Full range	1.25	0.8	
A_{VD} Large-signal differential voltage amplification	$V_{IC} = 2.5$ V, $V_O = 1$ V to 4 V	$R_L = 600 \Omega \ddagger$	25°C	0.9	1.3	V/mV
			25°C	0.5	0.5	
		$R_L = 1 \text{ M}\Omega \ddagger$	25°C	950	950	
r_{id}	Differential input resistance		25°C	1000	1000	$\text{G}\Omega$
r_j	Common-mode input resistance		25°C	1000	1000	$\text{G}\Omega$
c_i	Common-mode input capacitance	$f = 10$ kHz	25°C	8	8	pF
z_o	Closed-loop output impedance	$f = 1$ MHz, $A_V = 10$	25°C	140	140	Ω
CMRR	$V_{IC} = 0$ to 4.25 V, $V_O = 2.5$ V, $R_S = 50 \Omega$	25°C	70	75	70	dB
		Full range	70	70	70	

† Full range for the C suffix is 0°C to 70°C. Full range for the dual I suffix is –40°C to 85°C. Full range for the quad I suffix is –40°C to 125°C. Full range for the Q suffix is –40°C to 125°C. Full range for the M suffix is –55°C to 125°C.

‡ Referenced to 2.5 V

NOTE 4: Typical values are based on the input offset voltage shift observed through 168 hours of operating life test at $T_A = 150^\circ\text{C}$ extrapolated to $T_A = 25^\circ\text{C}$ using the Arrhenius equation and assuming an activation energy of 0.96 eV.

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**electrical characteristics at specified free-air temperature, $V_{DD} = 5$ V (unless otherwise noted)
(continued)**

PARAMETER	TEST CONDITIONS	T_A^\dagger	TLV244x			UNIT
			MIN	TYP	MAX	
k _{SVR}	Supply-voltage rejection ratio ($\Delta V_{DD}/\Delta V_{IO}$)	$V_{DD} = 4.4$ V to 8 V, $V_{IC} = V_{DD}/2$, No load	25°C Full range	80 80	95	dB
I _{DD}	Supply current (per channel)	$V_O = 2.5$ V, No load	25°C Full range	750 1100	1100	
						μA

† Full range for the C suffix is 0°C to 70°C. Full range for the dual I suffix is –40°C to 85°C. Full range for the quad I suffix is –40°C to 125°C. Full range for the Q suffix is –40°C to 125°C. Full range for the M suffix is –55°C to 125°C.

operating characteristics at specified free-air temperature, $V_{DD} = 5$ V

PARAMETER	TEST CONDITIONS	T_A^\dagger	TLV244x			UNIT
			MIN	TYP	MAX	
SR	Slew rate at unity gain	$V_O = 0.5$ V to 2.5 V, $R_L = 600 \Omega^\ddagger$, $C_L = 100 \text{ pF}^\ddagger$	25°C	0.75	1.4	V/μs
			Full range	0.75		
			Full range	0.5		
V _n	Equivalent input noise voltage	f = 10 Hz	25°C	130		nV/√Hz
		f = 1 kHz	25°C	16		
V _{N(PP)}	Peak-to-peak equivalent input noise voltage	f = 0.1 Hz to 1 Hz	25°C	1.8		μV
		f = 0.1 Hz to 10 Hz	25°C	3.6		
I _n	Equivalent input noise current		25°C	0.6		fA/√Hz
THD + N	Total harmonic distortion plus noise	$V_O = 1.5$ V to 3.5 V, f = 1 kHz, $R_L = 600 \Omega^\ddagger$	A _v = 1		0.017%	
			A _v = 10		0.17%	
			A _v = 100		1.5%	
	Gain-bandwidth product	f = 10 kHz, $R_L = 600 \Omega^\ddagger$, $C_L = 100 \text{ pF}^\ddagger$	25°C	1.81		MHz
B _{OM}	Maximum output-swing bandwidth	$V_O(\text{PP}) = 2$ V, $A_v = 1$, $R_L = 600 \Omega^\ddagger$, $C_L = 100 \text{ pF}^\ddagger$	25°C	0.5		MHz
t _s	Settling time	A _v = –1, Step = 0.5 V to 2.5 V, $R_L = 600 \Omega^\ddagger$, $C_L = 100 \text{ pF}^\ddagger$	To 0.1%		1.5	μs
			To 0.01%		2.6	
φ _m	Phase margin at unity gain	$R_L = 600 \Omega^\ddagger$, $C_L = 100 \text{ pF}^\ddagger$	25°C	68°		
	Gain margin		25°C	8		
						dB

† Full range for the C suffix is 0°C to 70°C. Full range for the dual I suffix is –40°C to 85°C. Full range for the quad I suffix is –40°C to 125°C. Full range for the Q suffix is –40°C to 125°C. Full range for the M suffix is –55°C to 125°C.

‡ Referenced to 2.5 V



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TYPICAL CHARACTERISTICS

Table of Graphs†

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	Inverting small-signal pulse response	37, 38
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	Gain margin	vs Load capacitance 49
B ₁	Unity-gain bandwidth	vs Load capacitance 50

† For all graphs where V_{DD} = 5 V, all loads are referenced to 2.5 V.

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WIDE-INPUT-VOLTAGE OPERATIONAL AMPLIFIERS

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TYPICAL CHARACTERISTICS

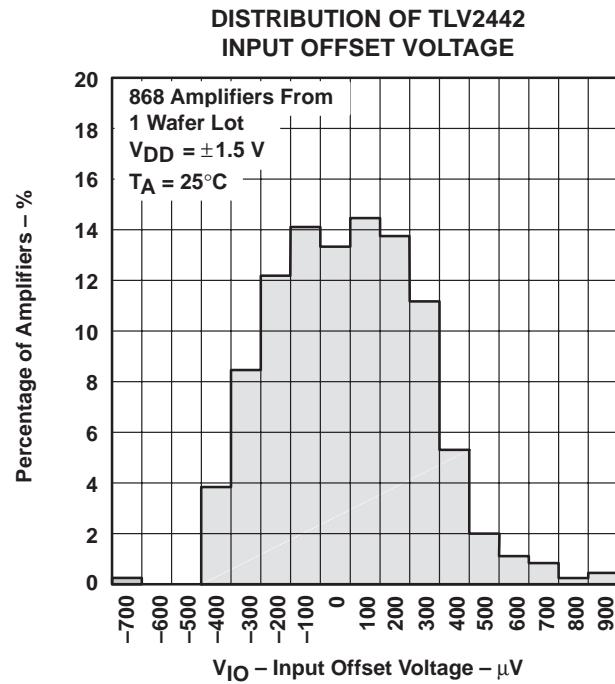


Figure 2

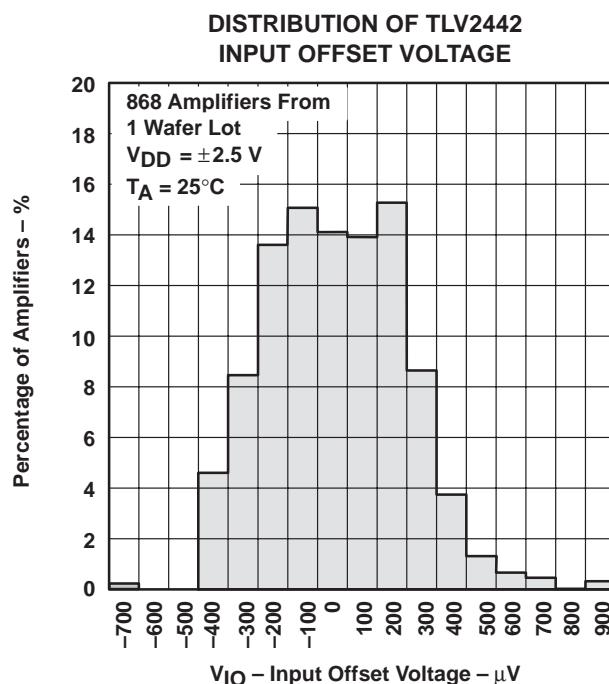


Figure 3

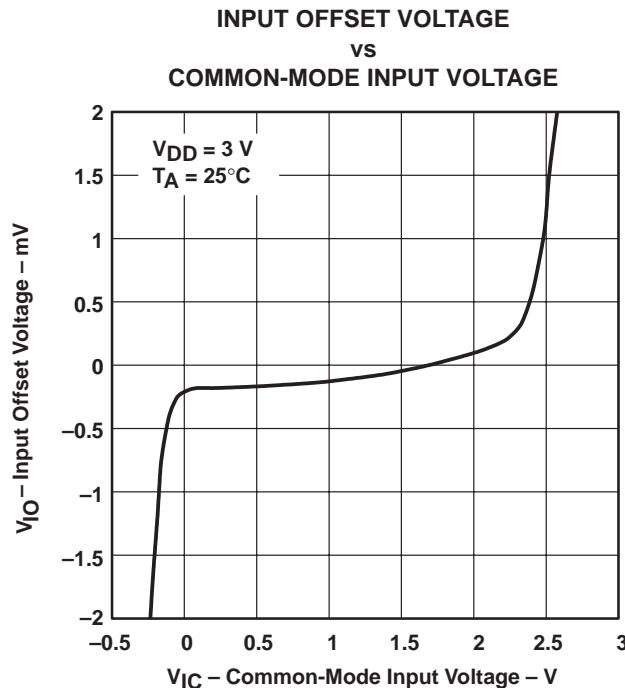


Figure 4

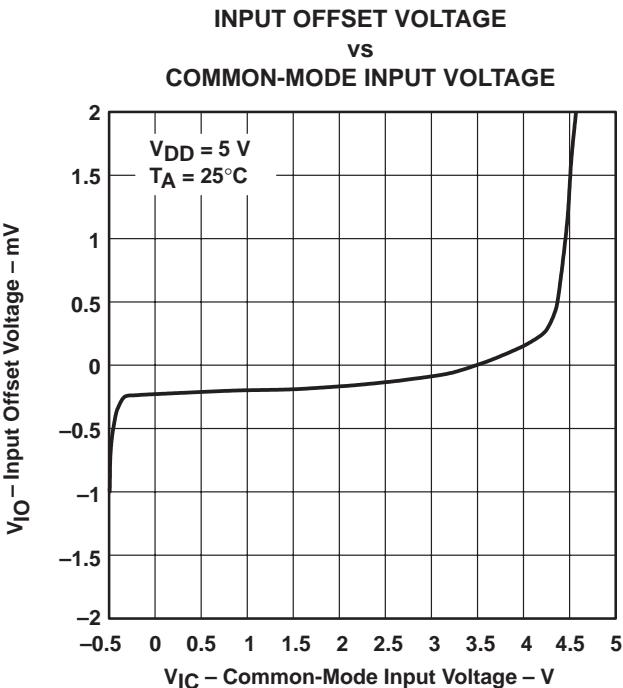


Figure 5

TYPICAL CHARACTERISTICS

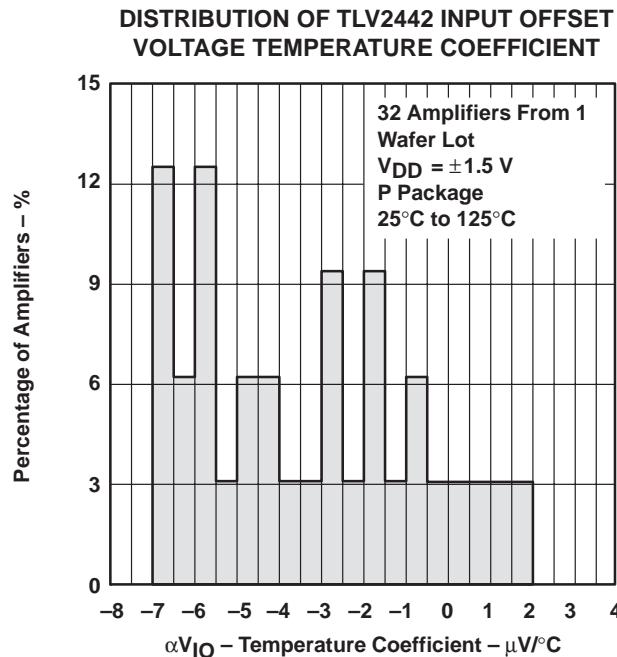


Figure 6

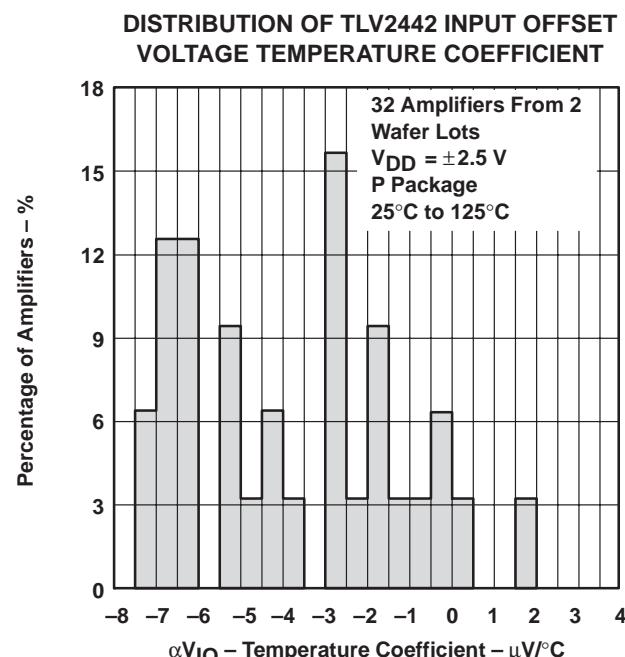


Figure 7

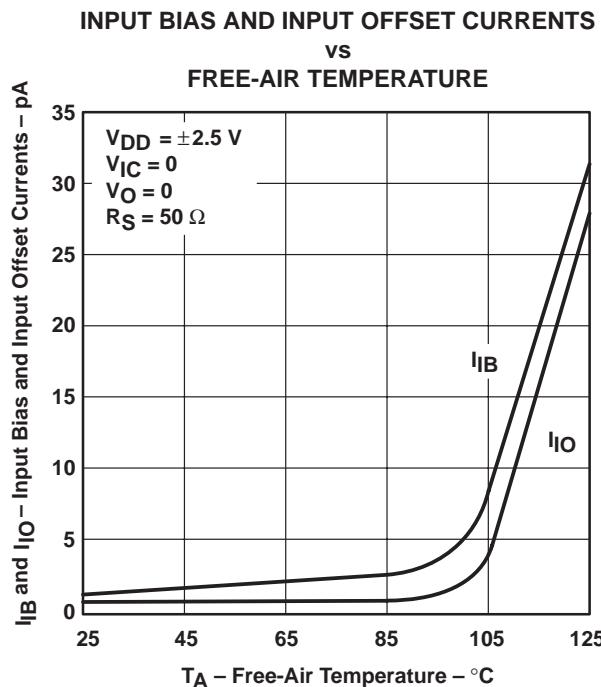


Figure 8

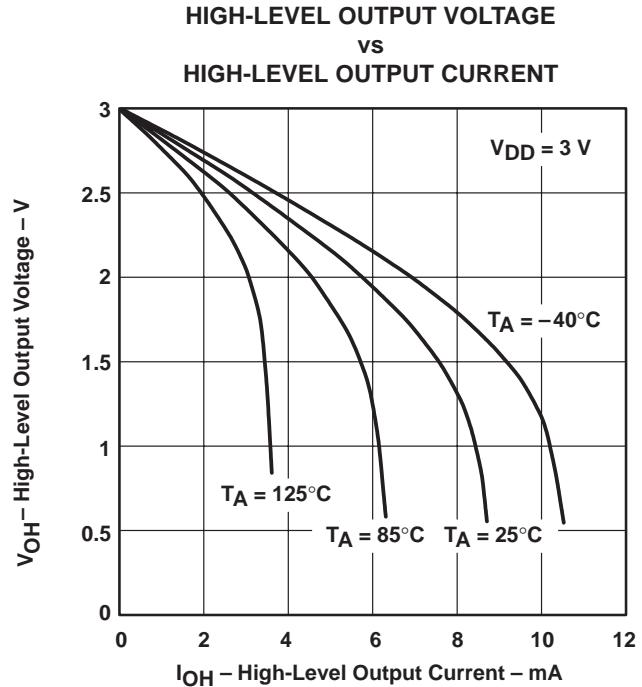


Figure 9

TLV2442, TLV2442A, TLV2444, TLV2444A
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WIDE-INPUT-VOLTAGE OPERATIONAL AMPLIFIERS

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TYPICAL CHARACTERISTICS

**HIGH-LEVEL OUTPUT VOLTAGE
vs
HIGH-LEVEL OUTPUT CURRENT**

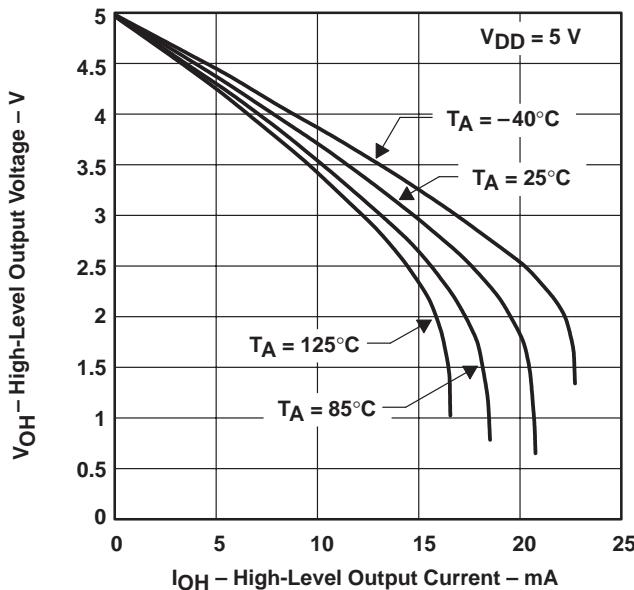


Figure 10

**LOW-LEVEL OUTPUT VOLTAGE
vs
LOW-LEVEL OUTPUT CURRENT**

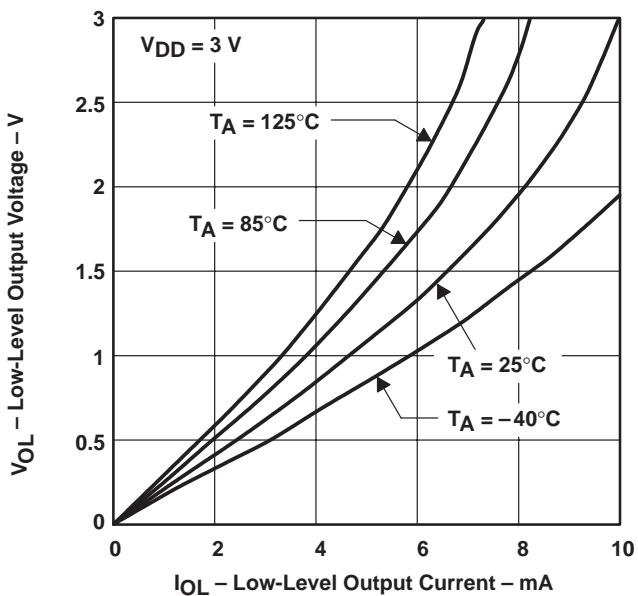


Figure 11

**LOW-LEVEL OUTPUT VOLTAGE
vs
LOW-LEVEL OUTPUT CURRENT**

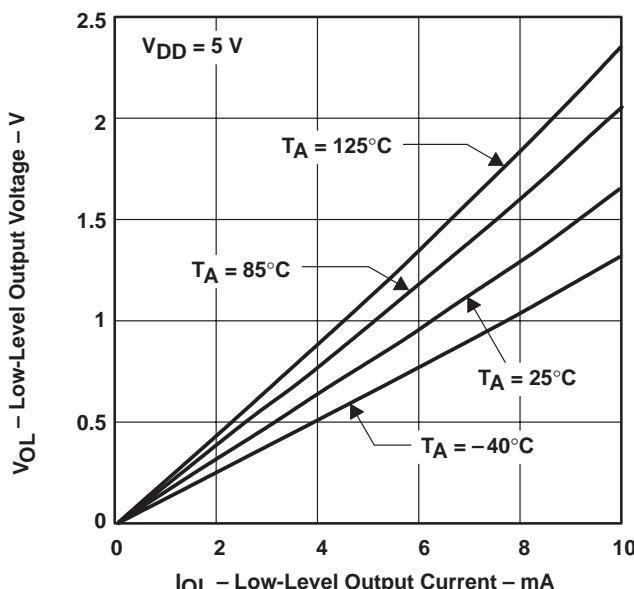


Figure 12

**MAXIMUM PEAK-TO-PEAK OUTPUT VOLTAGE
vs
FREQUENCY**

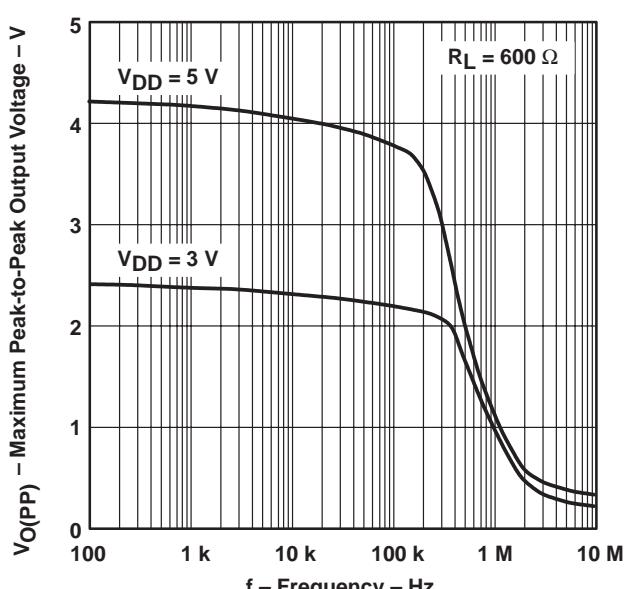


Figure 13

TYPICAL CHARACTERISTICS

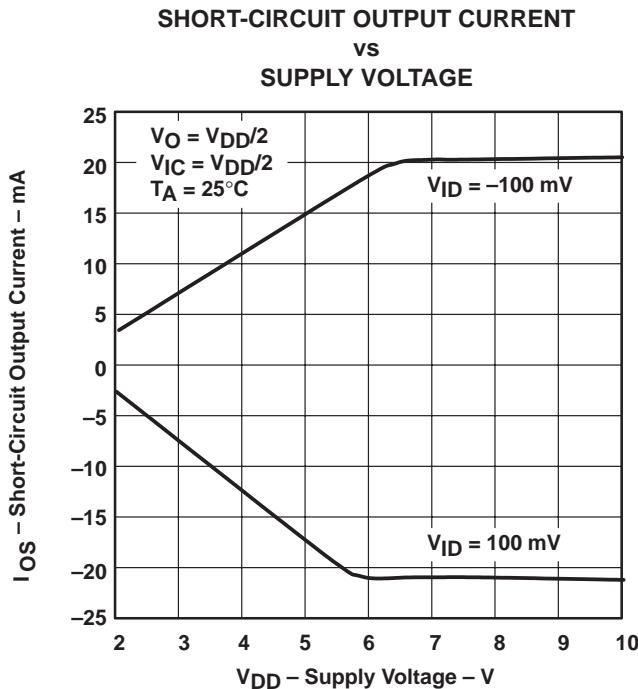


Figure 14

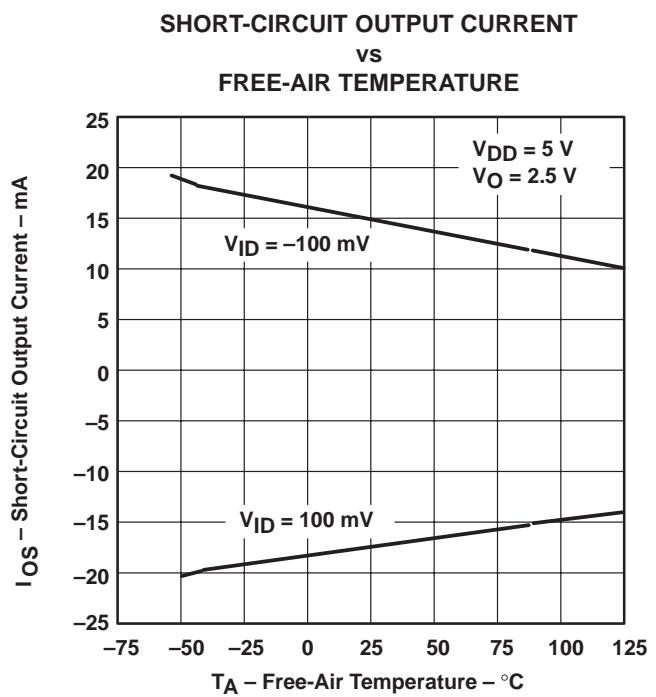


Figure 15

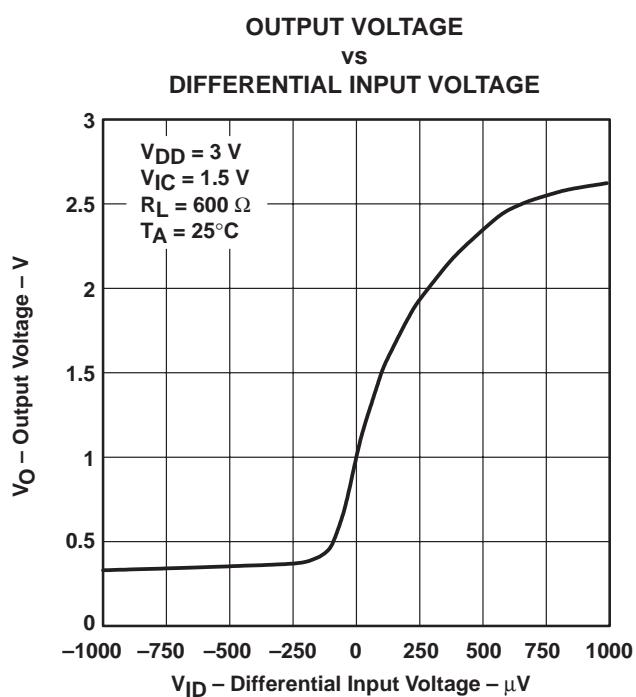


Figure 16

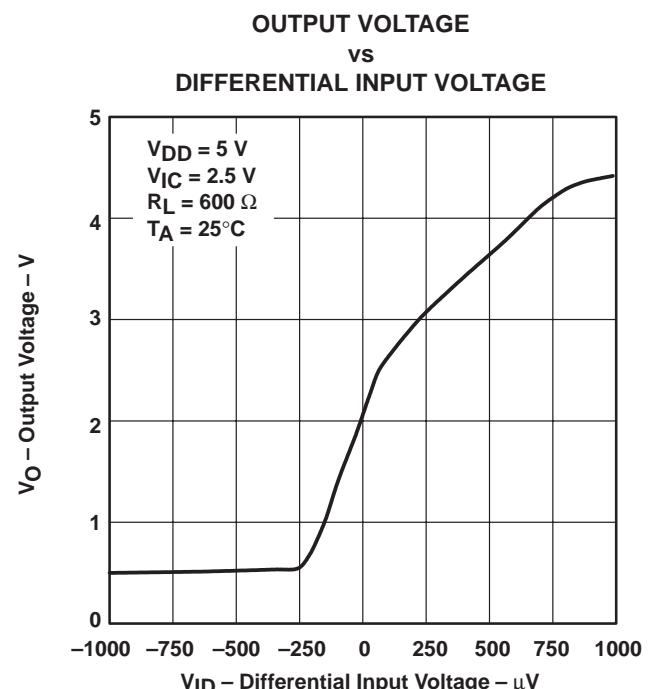


Figure 17

TLV2442, TLV2442A, TLV2444, TLV2444A
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TYPICAL CHARACTERISTICS

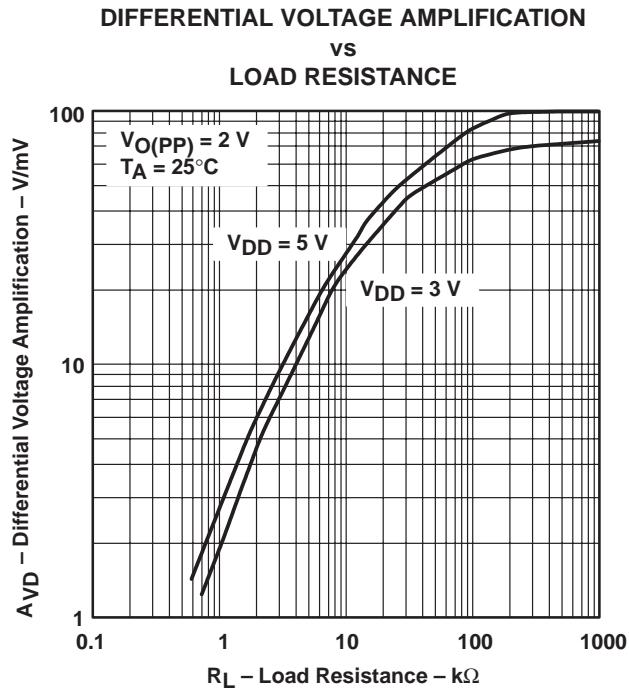


Figure 18

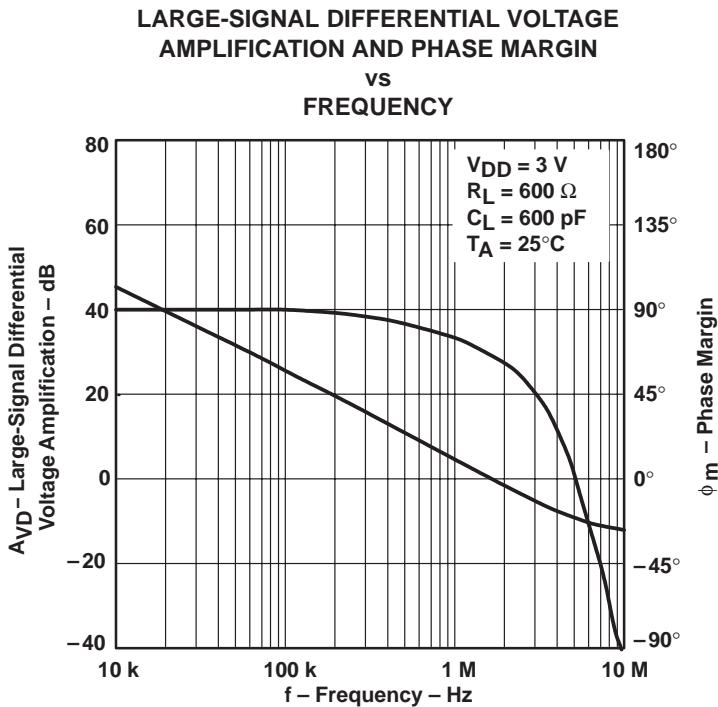


Figure 19

TYPICAL CHARACTERISTICS

**LARGE-SIGNAL DIFFERENTIAL VOLTAGE
AMPLIFICATION AND PHASE MARGIN
vs
FREQUENCY**

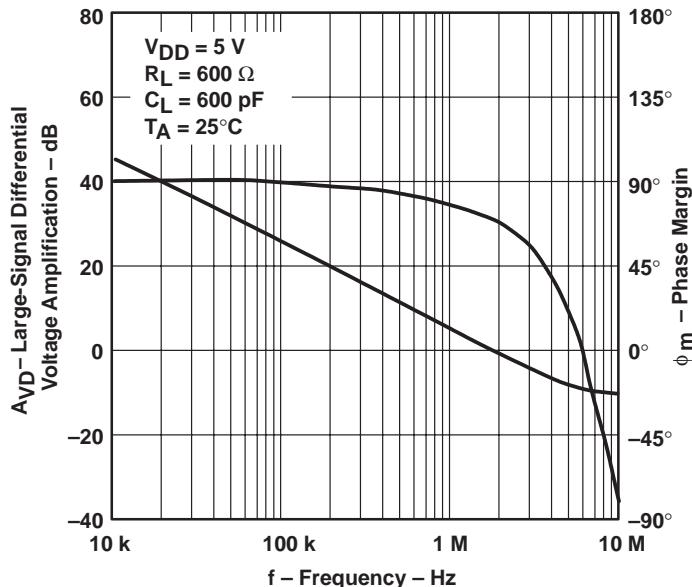


Figure 20

**LARGE-SIGNAL DIFFERENTIAL
VOLTAGE AMPLIFICATION
vs
FREE-AIR TEMPERATURE**

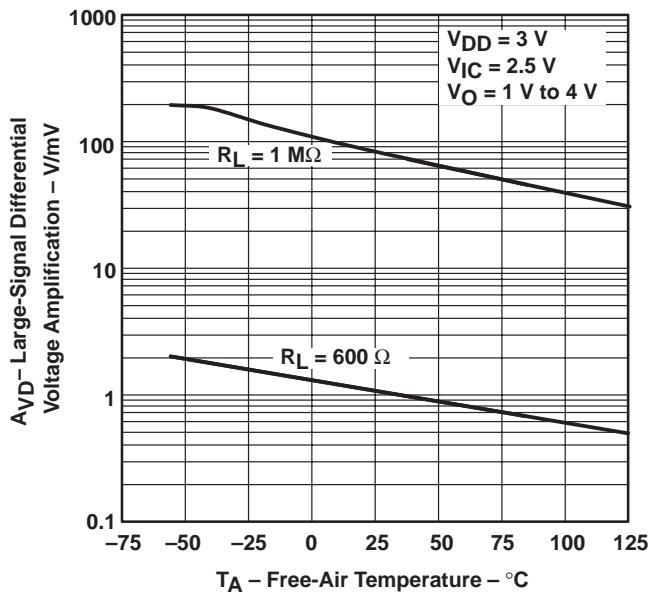


Figure 21

**LARGE-SIGNAL DIFFERENTIAL
VOLTAGE AMPLIFICATION
vs
FREE-AIR TEMPERATURE**

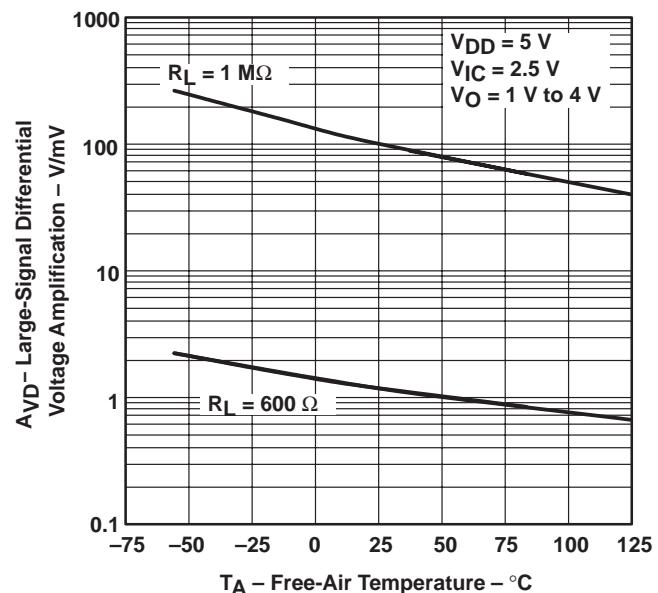


Figure 22

TLV2442, TLV2442A, TLV2444, TLV2444A
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WIDE-INPUT-VOLTAGE OPERATIONAL AMPLIFIERS

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TYPICAL CHARACTERISTICS

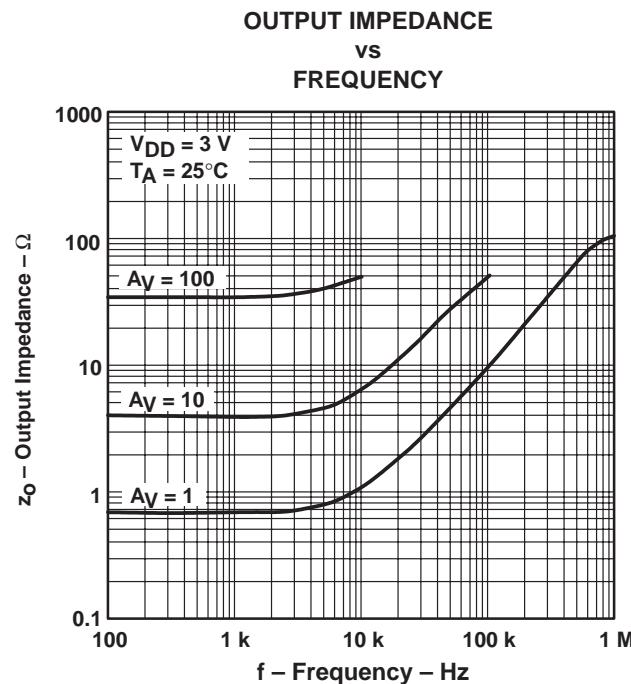


Figure 23

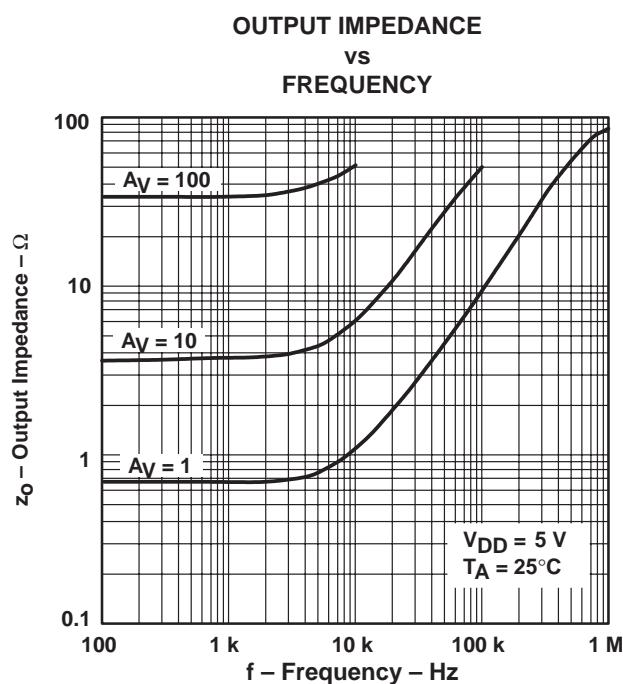


Figure 24

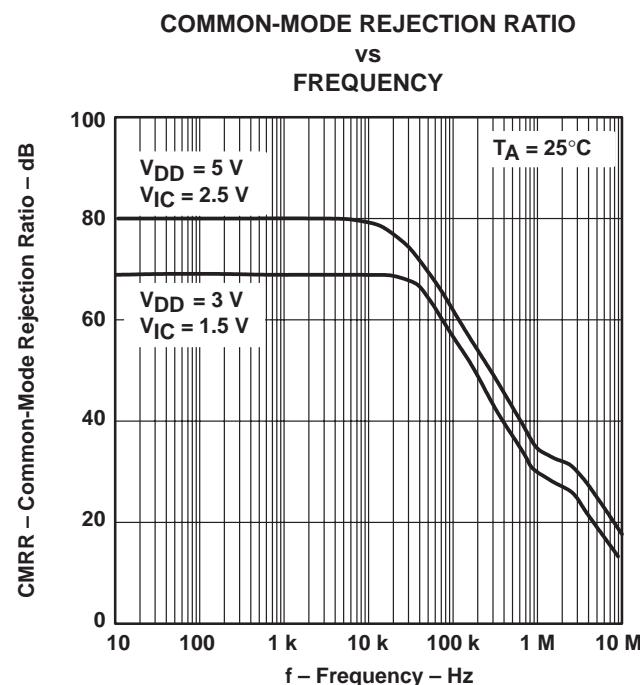


Figure 25

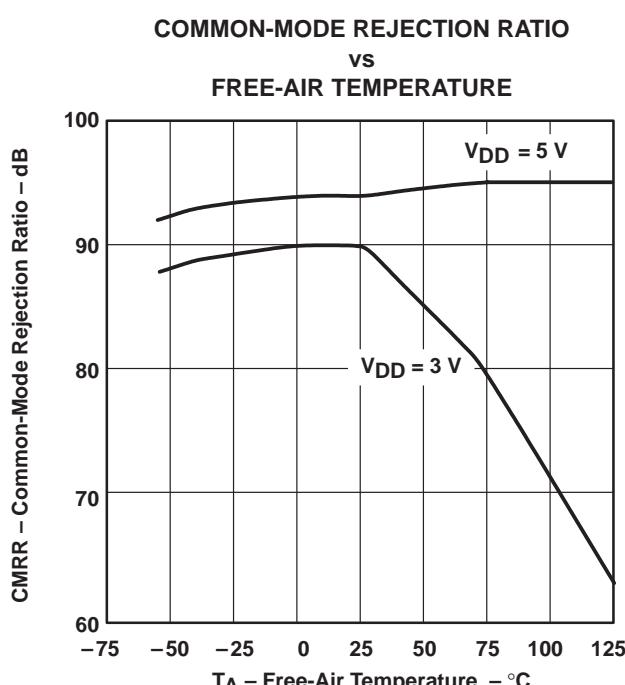


Figure 26

TYPICAL CHARACTERISTICS

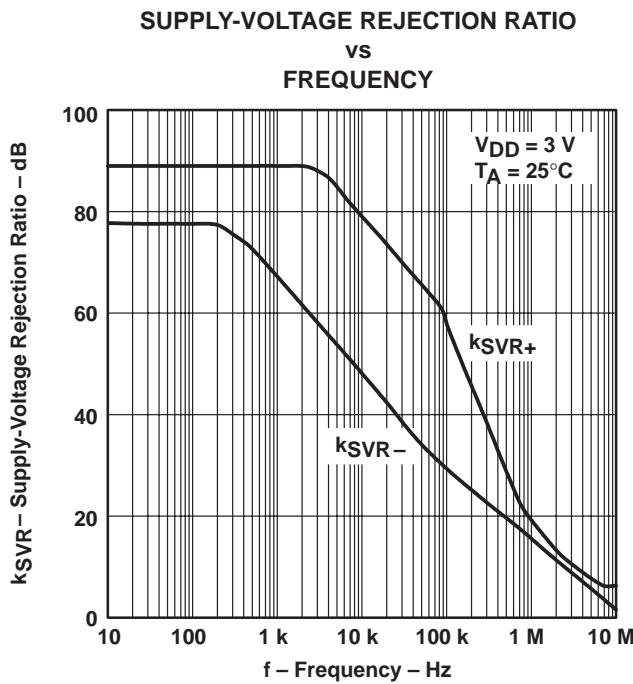


Figure 27

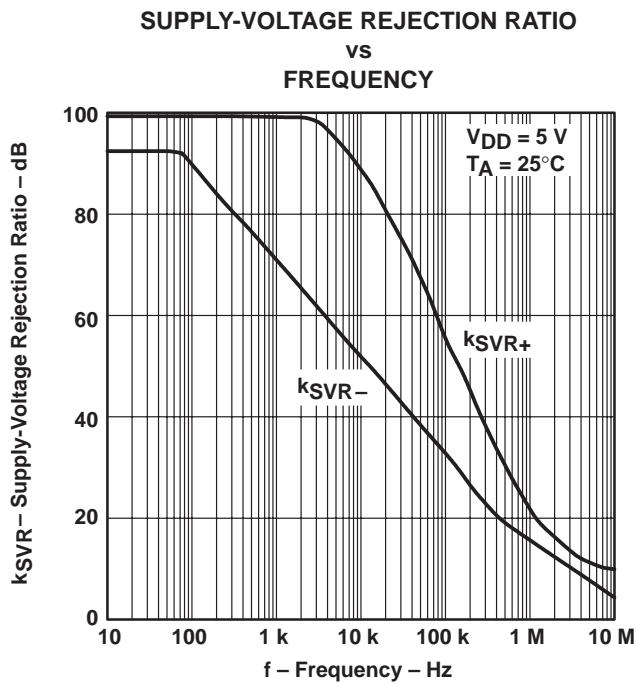


Figure 28

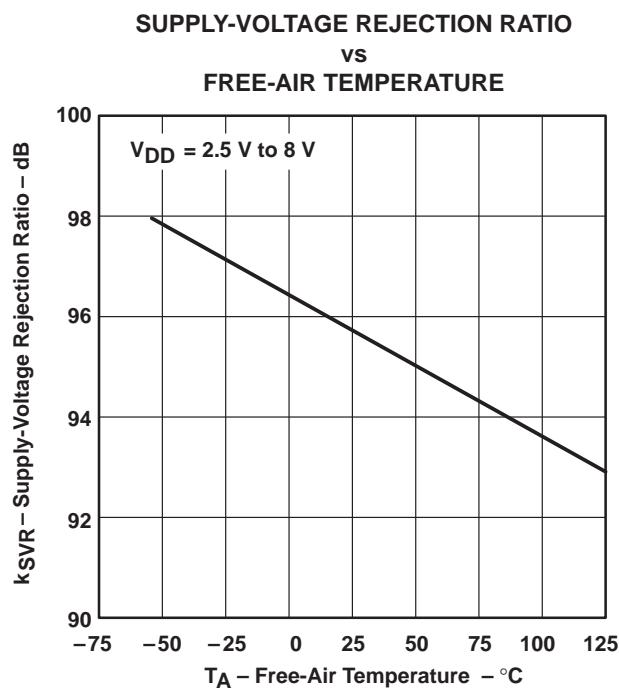


Figure 29

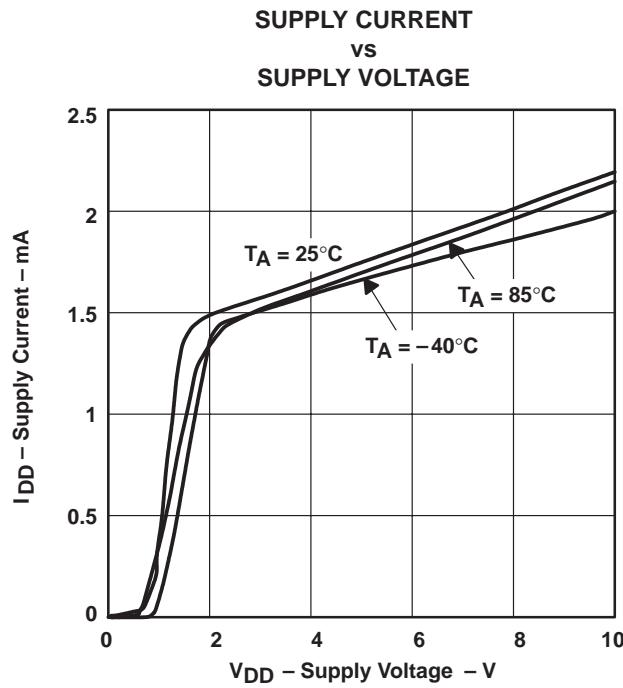


Figure 30

TLV2442, TLV2442A, TLV2444, TLV2444A
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TYPICAL CHARACTERISTICS

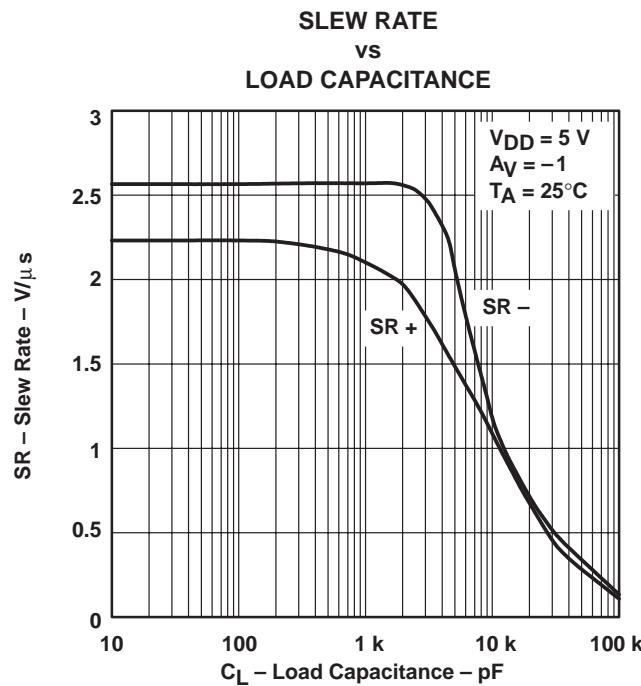


Figure 31

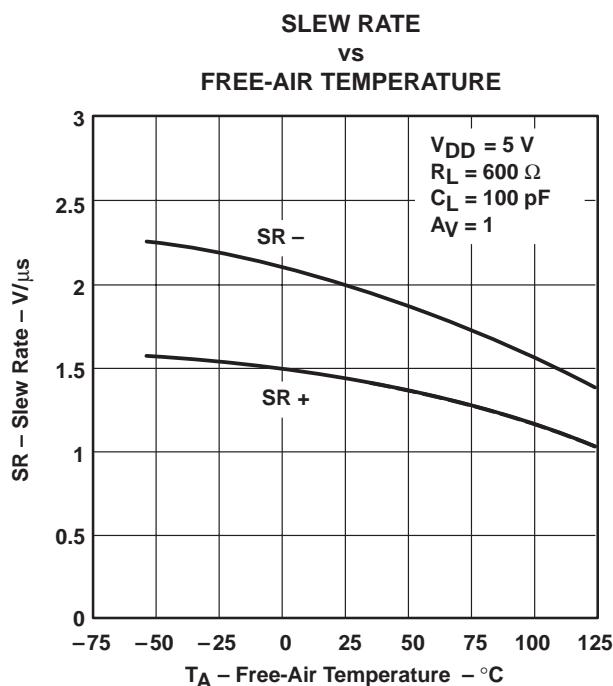


Figure 32

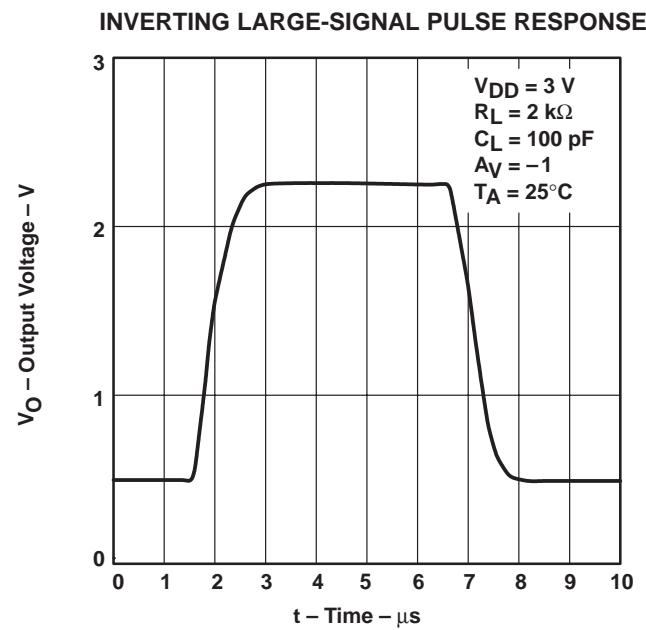


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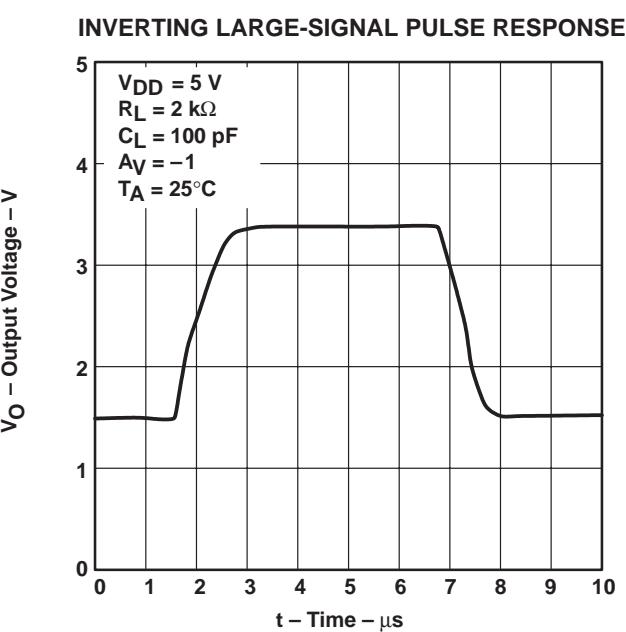


Figure 34

TYPICAL CHARACTERISTICS

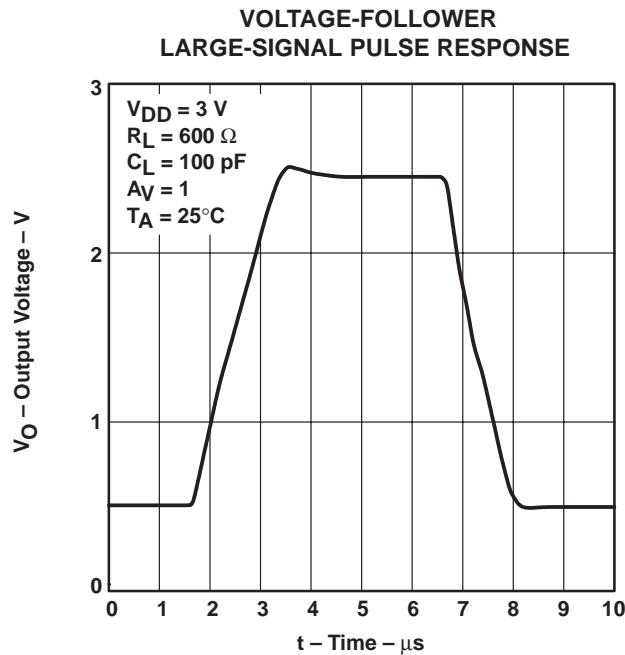


Figure 35

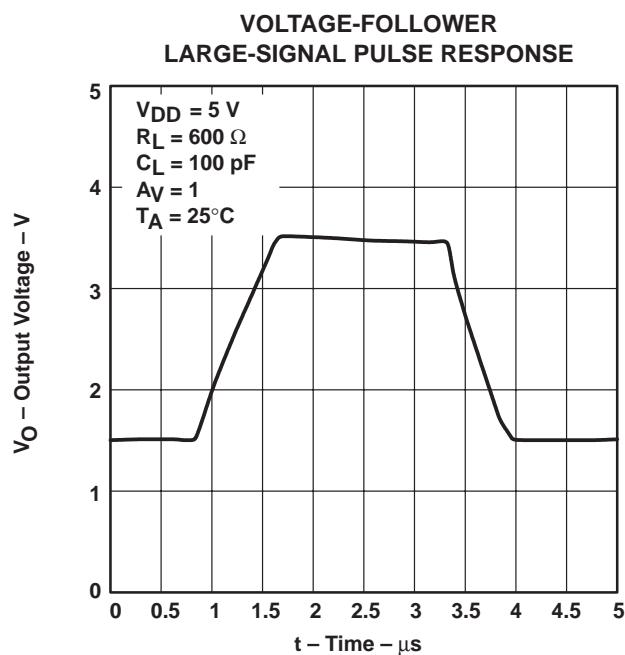


Figure 36

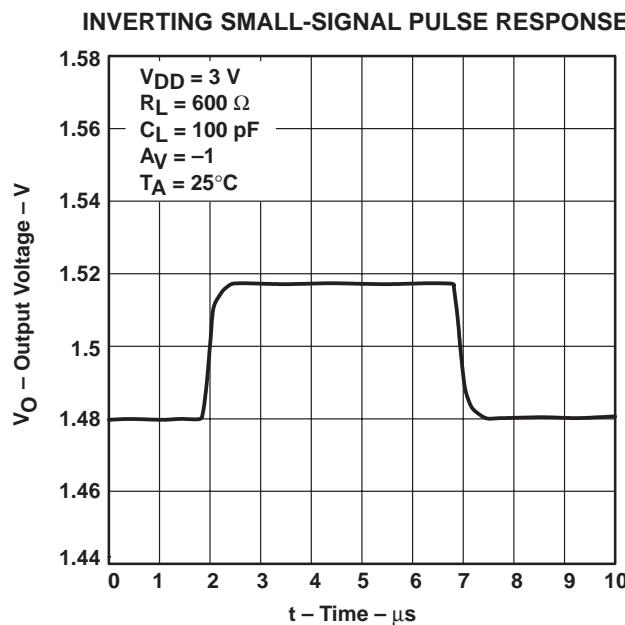


Figure 37

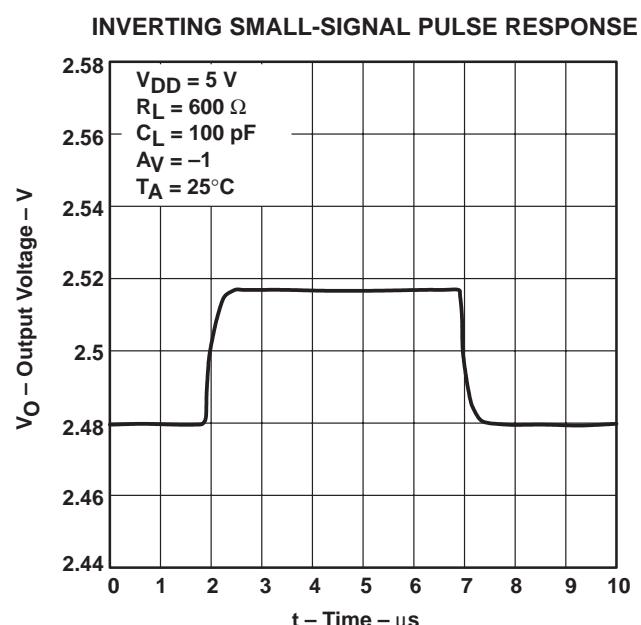


Figure 38

TLV2442, TLV2442A, TLV2444, TLV2444A
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WIDE-INPUT-VOLTAGE OPERATIONAL AMPLIFIERS

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TYPICAL CHARACTERISTICS

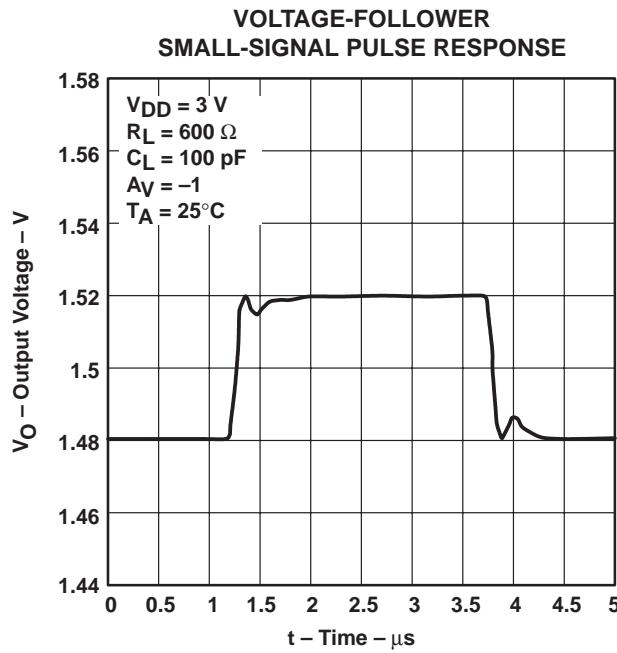


Figure 39

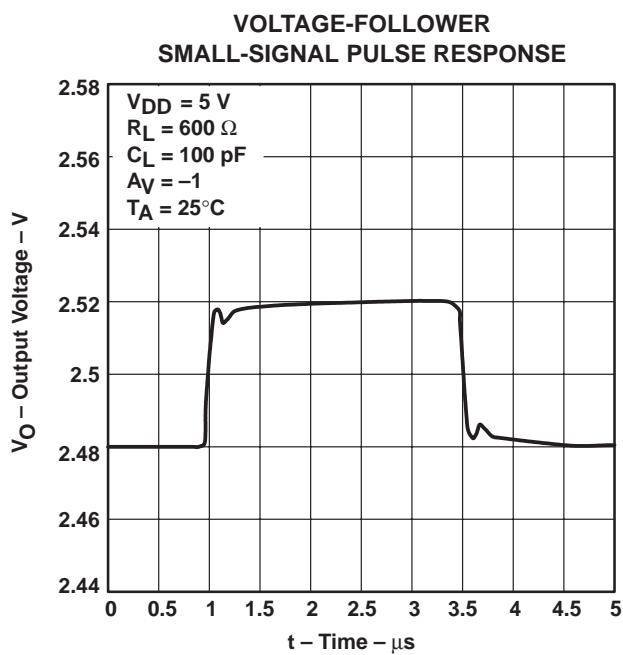


Figure 40

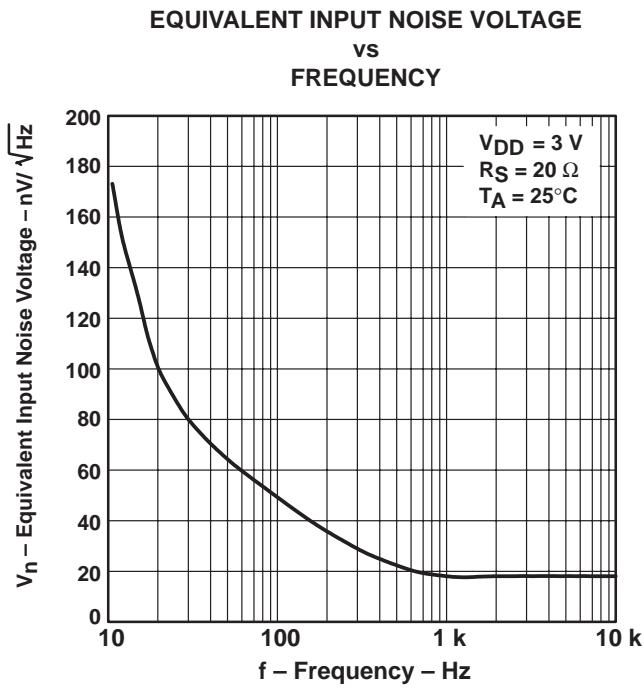


Figure 41

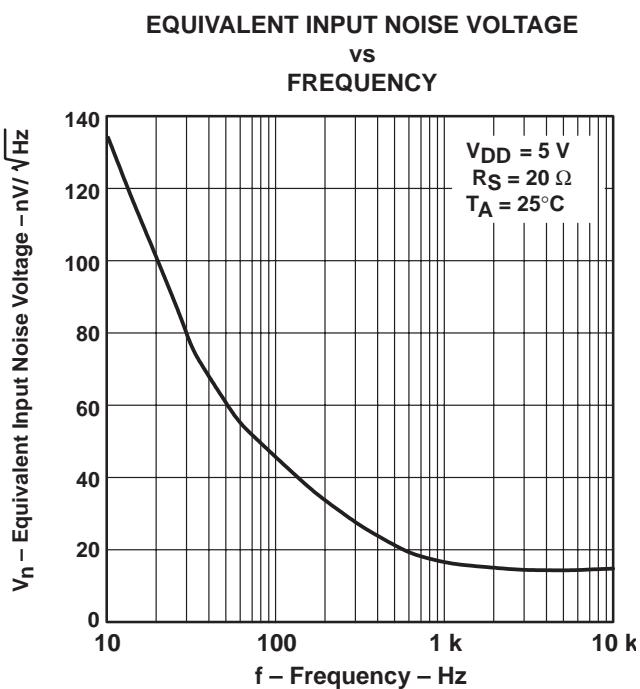


Figure 42

TYPICAL CHARACTERISTICS

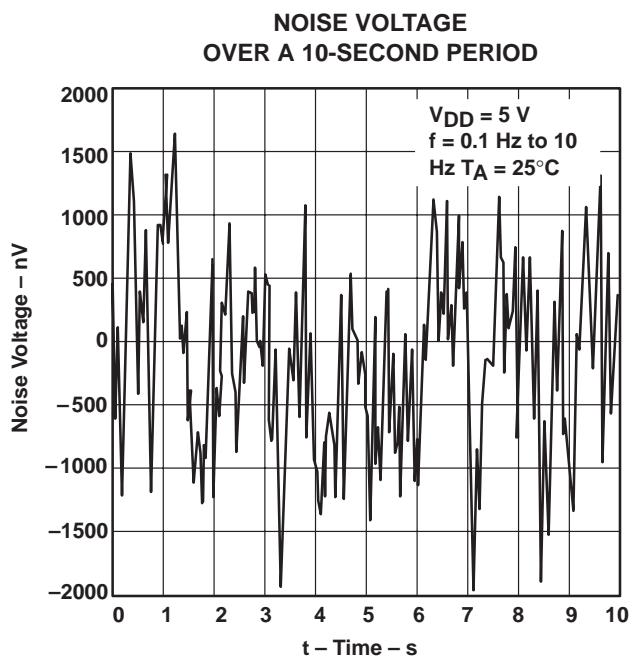


Figure 43

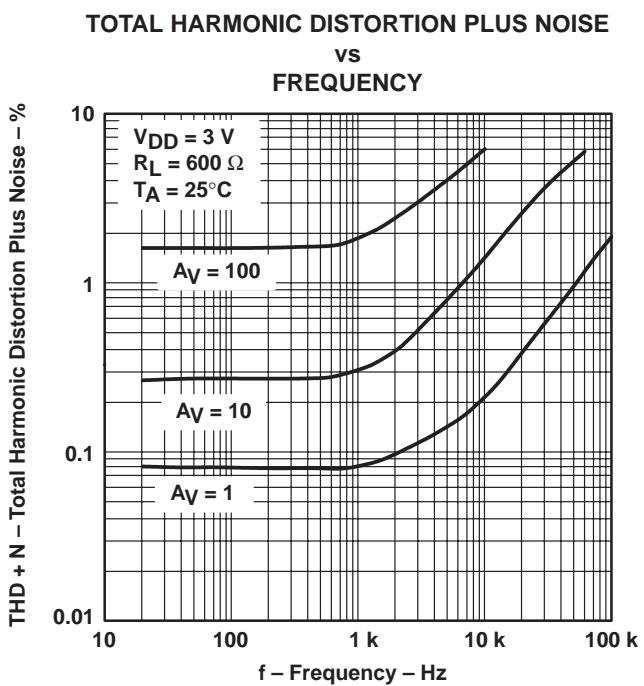


Figure 44

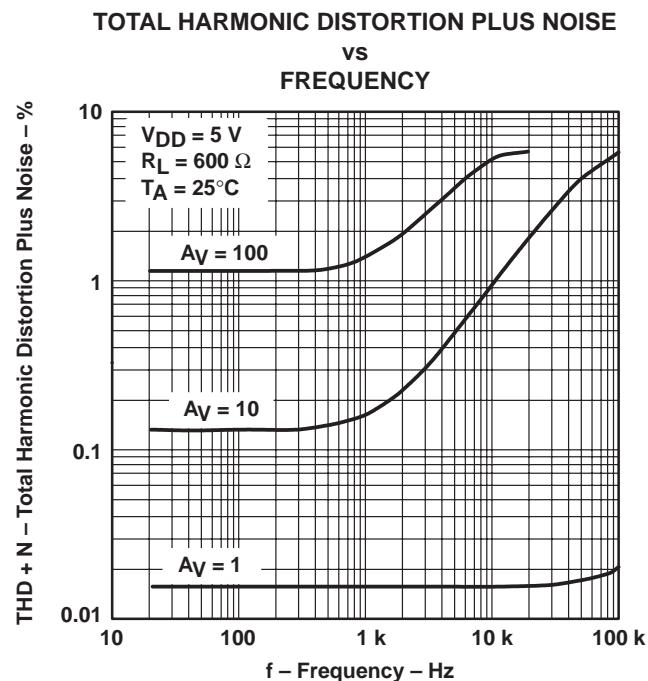


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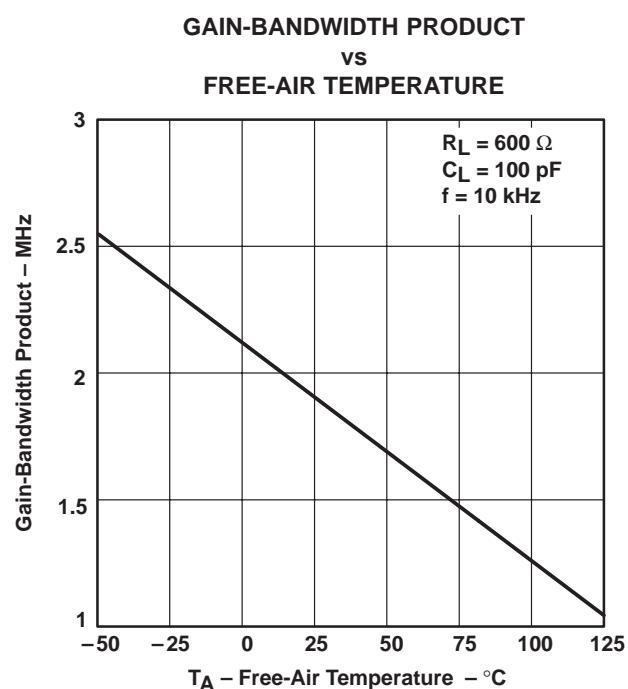


Figure 46

TLV2442, TLV2442A, TLV2444, TLV2444A
Advanced LinCMOS™ RAIL-TO-RAIL OUTPUT
WIDE-INPUT-VOLTAGE OPERATIONAL AMPLIFIERS

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TYPICAL CHARACTERISTICS

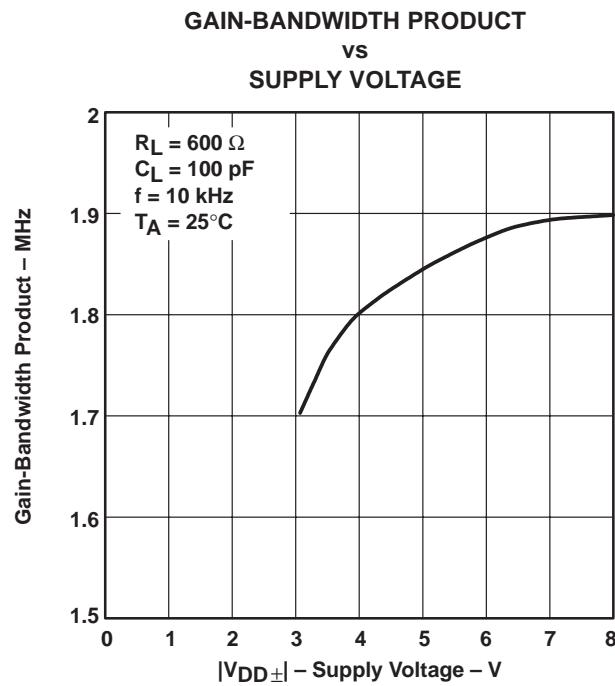


Figure 47

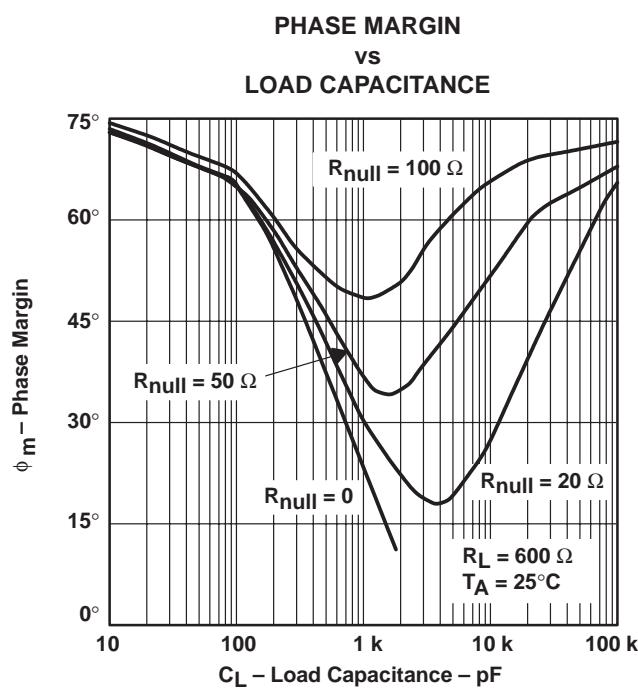


Figure 48

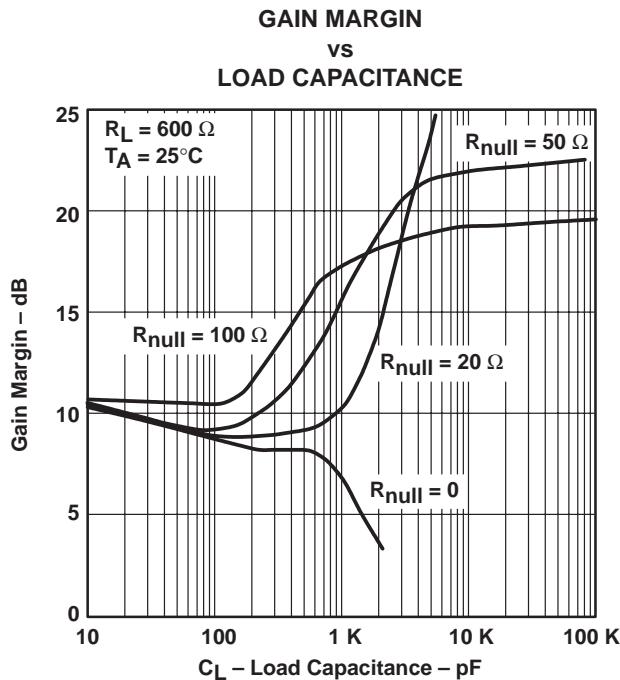


Figure 49

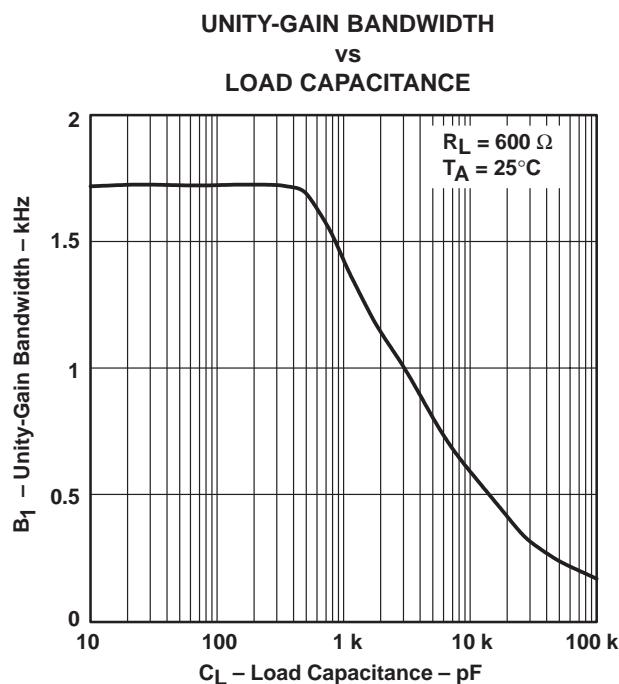


Figure 50

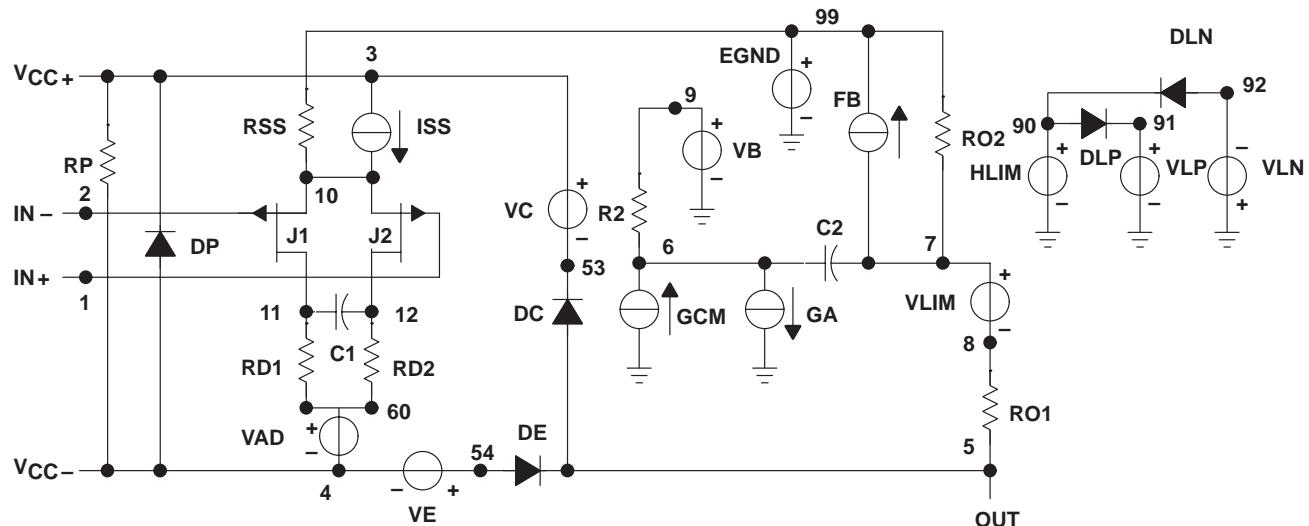
APPLICATION INFORMATION

macromodel information

Macromodel information provided was derived using *PSpice™ Parts™* model generation software. The Boyle macromodel (see Note 5) and subcircuit in Figure 51 were generated using the TLV244x typical electrical and operating characteristics at $T_A = 25^\circ\text{C}$. Using this information, output simulations of the following key parameters can be generated to a tolerance of 20% (in most cases):

- Maximum positive output voltage swing
- Maximum negative output voltage swing
- Slew rate
- Quiescent power dissipation
- Input bias current
- Open-loop voltage amplification
- Unity gain frequency
- Common-mode rejection ratio
- Phase margin
- DC output resistance
- AC output resistance
- Short-circuit output current limit

NOTE 5: G. R. Boyle, B. M. Cohn, D. O. Pederson, and J. E. Solomon, "Macromodeling of Integrated Circuit Operational Amplifiers," *IEEE Journal of Solid-State Circuits*, SC-9, 353 (1974).



```
.SUBCKT TLV2442 1 2 3 4 5
C1    11      12      14E-12
C2    6       7       60.00E-12
DC    5       53     DX
DE    54      5       DX
DLP   90      91     DX
DLN   92      90     DX
DP    4       3       DX
EGND  99      0       POLY (2) (3,0) (4,) 0 .5 .5
FB    7       99     POLY (5) VB VC VE VLP VLN 0
+ 984.9E3 -1E6 1E6 1E6 -1E6
GA    6       0       11      12 377.0E-6
GCM   0       6       10      99 134E-9
ISS   3       10     DC 216.OE-6
HLIM  90      0       VLIM 1K
J1    11      2       10 JX
J2    12      1       10 JX
R2    6       9       100.OE3
```

RD1	60	11	2.653E3
RD2	60	12	2.653E3
R01	8	5	50
R02	7	99	50
RP	3	4	4.310E3
RSS	10	99	925.9E3
VAD	60	4	-5
VB	9	0	DC 0
VC	3	53	DC .78
VE	54	4	DC .78
VLIM	7	8	DC 0
VLP	91	0	DC 1.9
VLN	0	92	DC 9.4

```
.MODEL DX D (IS=800.0E-18)
.MODEL JX PJF (IS=1.500E-12BETA=1.316E-3
+ VTO=-.270)
.ENDS
```

Figure 51. Boyle Macromodel and Subcircuit

**TLV2442, TLV2442A, TLV2444, TLV2444A
Advanced LinCMOS™ RAIL-TO-RAIL OUTPUT
WIDE-INPUT-VOLTAGE OPERATIONAL AMPLIFIERS**

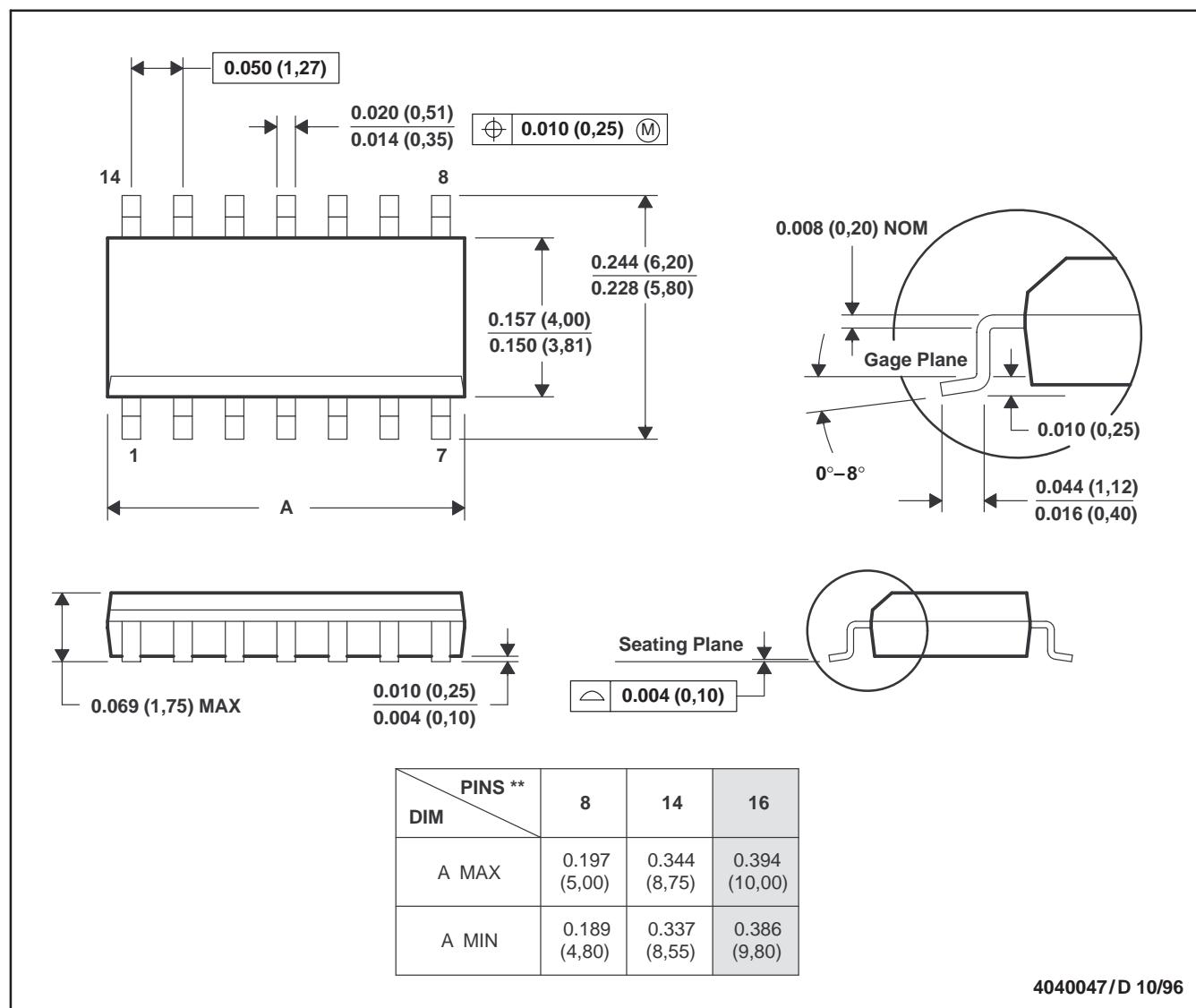
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MECHANICAL DATA

D (R-PDSO-G)**

14 PIN SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



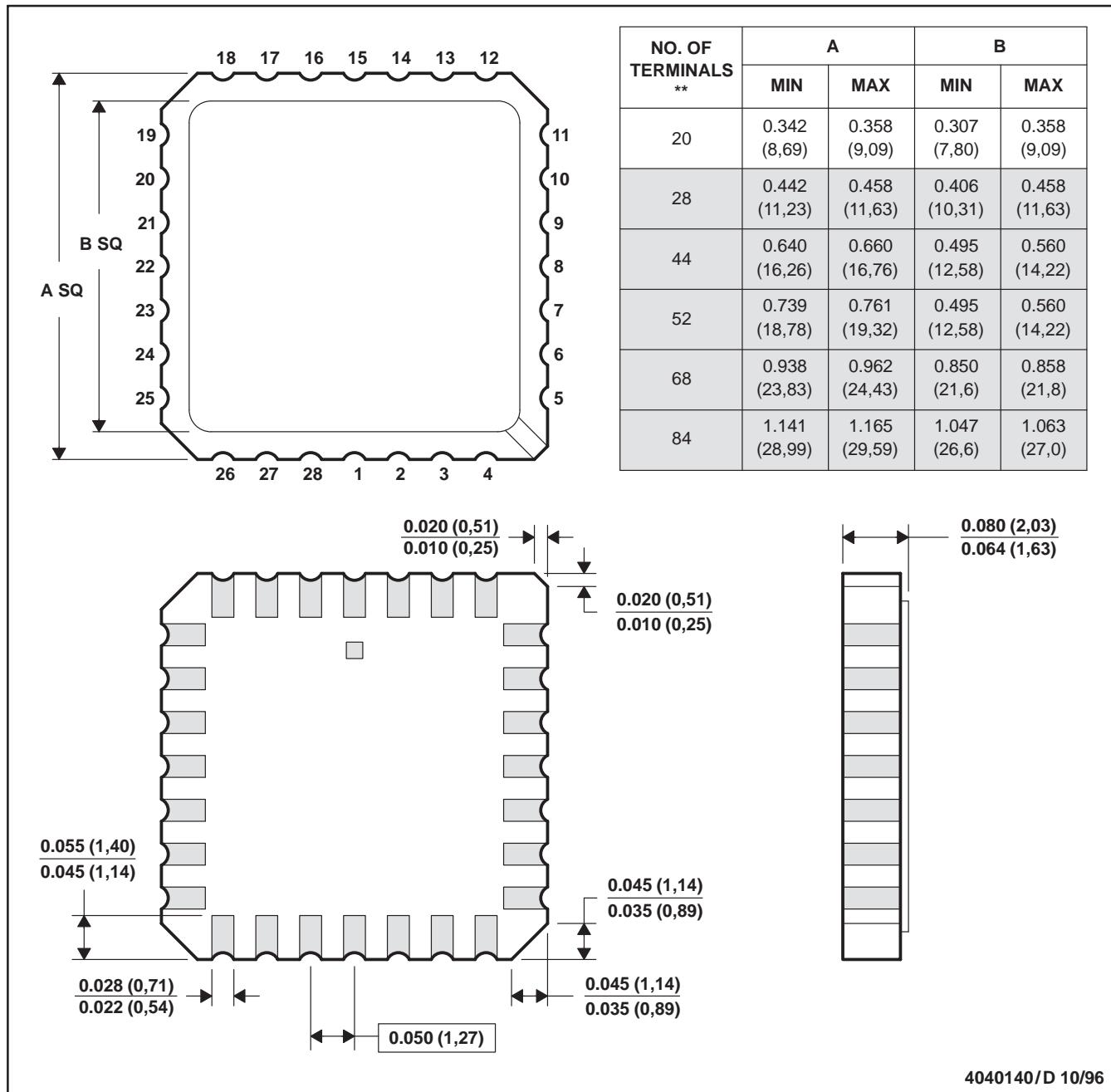
- NOTES: A. All linear dimensions are in inches (millimeters).
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion, not to exceed 0.006 (0.15).
 D. Falls within JEDEC MS-012

MECHANICAL DATA

FK (S-CQCC-N)**

28 TERMINAL SHOWN

LEADLESS CERAMIC CHIP CARRIER



4040140/D 10/96

- NOTES:
- All linear dimensions are in inches (millimeters).
 - This drawing is subject to change without notice.
 - This package can be hermetically sealed with a metal lid.
 - The terminals are gold plated.
 - Falls within JEDEC MS-004

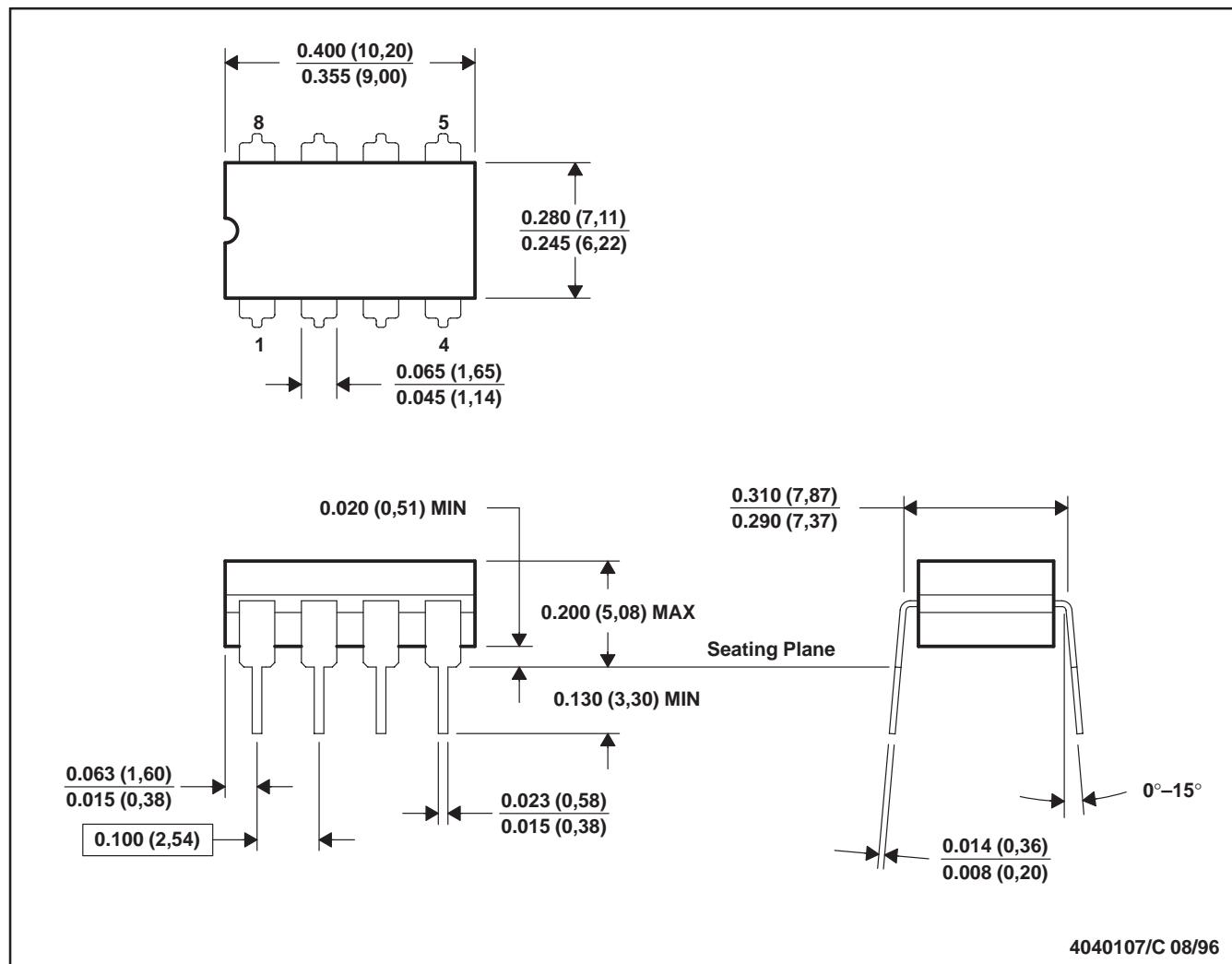
**TLV2442, TLV2442A, TLV2444, TLV2444A
Advanced LinCMOS™ RAIL-TO-RAIL OUTPUT
WIDE-INPUT-VOLTAGE OPERATIONAL AMPLIFIERS**

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MECHANICAL DATA

JG (R-GDIP-T8)

CERAMIC DUAL-IN-LINE PACKAGE



4040107/C 08/96

- NOTES:
- All linear dimensions are in inches (millimeters).
 - This drawing is subject to change without notice.
 - This package can be hermetically sealed with a ceramic lid using glass frit.
 - Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
 - Falls within MIL-STD-1835 GDIP1-T8

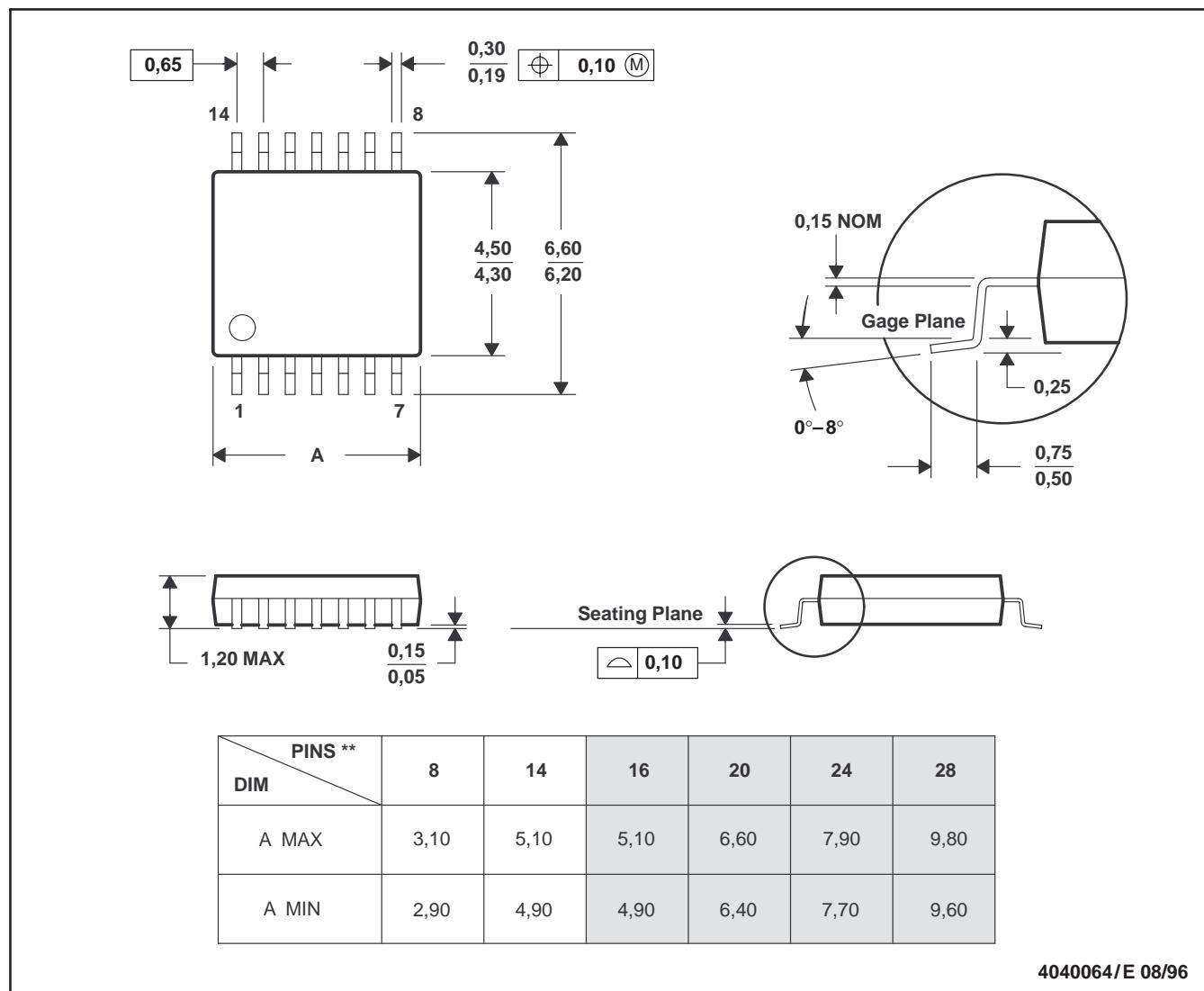
TLV2442, TLV2442A, TLV2444, TLV2444A
Advanced LinCMOS™ RAIL-TO-RAIL OUTPUT
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MECHANICAL DATA

PW (R-PDSO-G)**

14 PIN SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
 - D. Falls within JEDEC MO-153

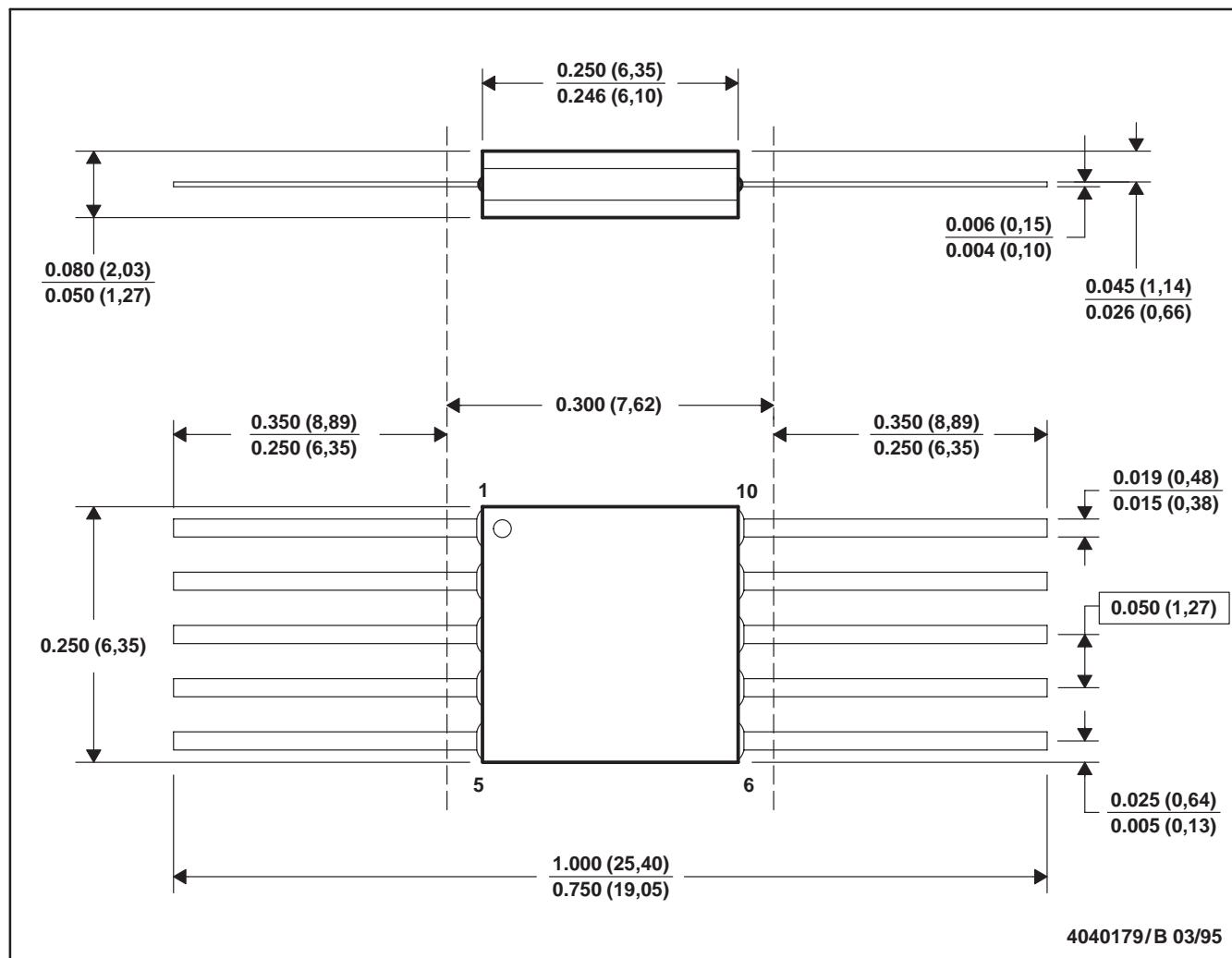
**TLV2442, TLV2442A, TLV2444, TLV2444A
Advanced LinCMOS™ RAIL-TO-RAIL OUTPUT
WIDE-INPUT-VOLTAGE OPERATIONAL AMPLIFIERS**

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MECHANICAL DATA

U (S-GDFP-F10)

CERAMIC DUAL FLATPACK



- NOTES: A. All linear dimensions are in inches (millimeters).
 B. This drawing is subject to change without notice.
 C. This package can be hermetically sealed with a ceramic lid using glass frit.
 D. Index point is provided on cap for terminal identification only.
 E. Falls within MIL STD 1835 GDFF1-F10 and JEDEC MO-092AA

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